

conga-TCA4

COM Express 2.1 Type 6 Compact Module with Intel® Braswell Processors

User's Guide

Revision 1.7

Revision History

Revision	Date (yyyy-mm-dd)	Author	Changes
0.1	2016-01-18	MKA	<ul style="list-style-type: none">• Preliminary release
0.2	2016-01-27	MKA	<ul style="list-style-type: none">• Amended processor information throughout document to reflect the changes in Intel SKU Stepping
1.0	2016-07-11	AEM	<ul style="list-style-type: none">• Updated section 2.5 "Power Consumption"• Added passive cooling solution to section 4• Added sections 9 "System Resources", 10 "BIOS Setup Description " and 11 "Additional BIOS Features"• Updated the whole document
1.1	2017-05-22	AEM	<ul style="list-style-type: none">• Corrected the supported EDID version in section 2.1 "Feature List"• Corrected the nominal voltage range in the diagram in section 2.4 "Supply Voltage Standard Power"• Updated section 2.5 "Power Consumption"• Updated the features supported by the SATA host controller in section 5.1.3 "SATA"• Deleted the note that console redirection is only available with external SIO in sections 10.4.11 "Super IO Submenu" and 10.4.12 "Serial Port Console Redirection Submenu"
1.2	2018-12-21	AEM	<ul style="list-style-type: none">• Updated the information about handling electrostatic sensitive devices in preface section• Updated the note in section 2.2 "Supported Operating Systems"• Added the power consumption values for PN:048314 in table 5 "Power Consumption Values"• Deleted all references to section 8.5 "Boot Strap Signals"• Updated section 10 "BIOS Setup Description"• Added sub-sections to section 11 "Additional BIOS Features" and updated section 11.4 "Supported Flash Devices"
1.3	2020-05-04	AEM	<ul style="list-style-type: none">• Reformatted and updated section 4 "Cooling Solutions"• Updated the link for power supply implementation guidelines in section 5.1.13 "Power Control"• Added note about the minimum pulse width required for proper button detection in table 21 "Power and System Management Signal Descriptions"• Updated section 6.1.1 "eMMC 4.51" and added note about eMMC operation• Added information about congatec MLF file to section 11 "Additional BIOS Features". Updated section 11.3 "Updating the BIOS" and added caution note. Added section 11.4 "Recovering from External Flash"• Deleted section 12 "Industry Specifications"
1.4	2021-04-19	AEM	<ul style="list-style-type: none">• Updated table 2 "conga-TCA4 Variants", table 3 "Feature Summary", table 8 "Display Combination" and table 15 "TMDS Signal Descriptions"• Restructured the whole document• Updated section 3 "Block Diagram" and section 5.1.2 "Display Interfaces"• Updated and moved DisplayPort to section 5.1.2.1 "DisplayPort (DP)"• Deleted section 5.2.3 "HDMI" and section 5.2.4 "DVI"• Added note to table 15 "TMDS Signal Descriptions"
1.5	2021-07-31	AEM	<ul style="list-style-type: none">• Added Software License Information• Changed congatec AG to congatec GmbH• Re-arranged section 6 "Additional Features"• Rephrased and updated section 6.4 "OEM BIOS Customization"

1.6	2021-11-16	AEM	<ul style="list-style-type: none">Deleted HDMI references from section 1.2 "Options Information", section 2.1 "Feature List" and section 5.1.2 "Display Interfaces"
1.7	2023-12-11	AEM	<ul style="list-style-type: none">Updated the title pageUpdated the RoHS statementAdded a note about optimal storage conditions to section 2.7 "Environmental Specifications"Added note about the storage of congatec cooling solutions to section 4 "Cooling Solutions"Updated section 6.3.4 "Power Loss Control"

Preface

This user's guide provides information about the components, features, connectors and BIOS Setup menus available on the conga-TCA4. It is one of three documents that should be referred to when designing a COM Express™ application. The other reference documents that should be used include the following:

COM Express™ Design Guide
COM Express™ Specification

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Contents

1	Introduction	12	5.1.11	SD Card	27
1.1	COM Express™ Concept.....	12	5.1.12	General Purpose Serial Interface (UART)	28
1.2	Options Information.....	13	5.1.13	Power Control	28
2	Specifications	14	5.1.14	Power Management.....	29
2.1	Feature List	14	6	Additional Features.....	30
2.2	Supported Operating Systems	15	6.1	eMMC	30
2.3	Mechanical Dimensions	15	6.2	Low Voltage Memory (DDR3L).....	30
2.4	Supply Voltage Standard Power	16	6.3	congatec Board Controller (cBC)	31
2.4.1	Electrical Characteristics	16	6.3.1	Board Information	31
2.4.2	Rise Time	16	6.3.2	General Purpose Input/Output.....	31
2.5	Power Consumption	17	6.3.3	Fan Control	31
2.6	Supply Voltage Battery Power	18	6.3.4	Power Loss Control	32
2.7	Environmental Specifications.....	19	6.3.5	Watchdog	32
3	Block Diagram.....	20	6.3.6	I ² C Bus.....	33
4	Cooling Solutions.....	21	6.4	OEM BIOS Customization.....	33
4.1	CSP Dimensions.....	22	6.4.1	OEM Default Settings	33
4.2	HSP Dimensions.....	23	6.4.2	OEM Boot Logo.....	33
5	Connector Rows.....	24	6.4.3	OEM POST Logo	33
5.1	Primary and Secondary Connector Rows.....	24	6.4.4	OEM BIOS Code/Data.....	34
5.1.1	PCI Express™	24	6.4.5	OEM DXE Driver	34
5.1.2	Display Interfaces.....	24	6.5	congatec Battery Management Interface	34
5.1.2.1	DisplayPort (DP)	25	6.6	API Support (CGOS/EAPI)	35
5.1.2.2	LVDS.....	25	6.7	Security Features.....	35
5.1.3	USB 2.0	26	6.8	Suspend to Ram.....	35
5.1.4	SATA	26	7	conga Tech Notes	36
5.1.5	Gigabit Ethernet	26	7.1	Intel Braswell SoC Features	36
5.1.6	High Definition Audio (HDA) Interface	27	7.1.1	Processor Core.....	36
5.1.7	LPC Bus.....	27	7.1.1.1	Intel Virtualization Technology.....	36
5.1.8	I ² C Bus	27	7.1.1.2	Thermal Management	37
5.1.9	ExpressCard™	27	7.2	ACPI Suspend Modes and Resume Events.....	38
5.1.10	SPI.....	27	7.3	USB Port Mapping	38
			8	Signal Descriptions and Pinout Tables.....	39
			8.1	Connector Signal Descriptions	40

9	System Resources	62	10.4.14	PPM Configuration Submenu	78
9.1	I/O Address Assignment.....	62	10.4.15	Thermal Configuration.....	78
9.1.1	LPC Bus.....	62	10.4.16	SATA Submenu	79
9.2	PCI Configuration Space Map	63	10.4.16.1	Software Feature Mask Configuration Submenu	79
9.3	PCI Interrupt Routing Map.....	64	10.4.17	LPSS & SCC Configuration Submenu	80
9.4	I ² C Bus	64	10.4.18	PCI & PCI Express	81
9.5	SMBus.....	64	10.4.19	UEFI Network Stack	82
10	BIOS Setup Description	65	10.4.20	CSM & Option ROM Control Submenu.....	82
10.1	Entering the BIOS Setup Program.....	65	10.4.21	Info Report Configuration	83
10.1.1	Boot Selection Popup.....	65	10.4.22	NVMe Submenu.....	83
10.2	Setup Menu and Navigation.....	65	10.4.23	USB Submenu	83
10.3	Main Setup Screen.....	66	10.4.24	Platform Trust Technology	84
10.4	Advanced Setup	67	10.4.25	Security Configuration	84
10.4.1	Watchdog Submenu	68	10.4.26	Intel® RMT Configuration Submenu.....	84
10.4.2	Hardware Health Monitoring Submenu	69	10.4.27	PC Speaker Submenu	85
10.4.3	Graphics Submenu.....	70	10.5	Chipset Setup	85
10.4.4	Intel® I211 Gigabit Network Connection Submenu	71	10.5.1	Processor (Integrated Components) Submenu.....	85
10.4.4.1	NIC Configuration Submenu	71	10.5.1.1	Intel® IGD Configuration Submenu.....	86
10.4.5	Driver Health Submenu.....	72	10.5.1.2	Graphics Power Management Control Submenu	87
10.4.5.1	Intel® PRO/1000 Submenu.....	72	10.5.1.3	Memory Configuration Options Submenu	87
10.4.6	Trusted Computing Submenu.....	72	10.5.2	Platform Controller Hub (PCH) Submenu	89
10.4.7	RTC Wake Submenu	72	10.5.2.1	Security Configuration Submenu	89
10.4.8	Module Serial Ports Submenu	72	10.5.2.2	Azalia Configuration Submenu	89
10.4.9	Reserve Legacy Interrupt Submenu.....	73	10.5.2.3	USB Configuration Submenu.....	90
10.4.10	ACPI Submenu.....	73	10.5.2.4	PCI Express Configuration Submenu.....	91
10.4.11	Super IO Submenu	73	10.6	Security Setup.....	93
10.4.11.1	Serial Port 1 Configuration Submenu	74	10.6.1	Security Settings	93
10.4.11.2	Serial Port 2 Configuration Submenu	74	10.6.2	Secure Boot Menu	93
10.4.11.3	Parallel Port Configuration Submenu.....	74	10.6.2.1	Key Management Submenu	94
10.4.12	Serial Port Console Redirection Submenu.....	75	10.7	Boot Setup.....	94
10.4.12.1	Console Redirection Settings Submenu	75	10.7.1	Boot Settings Configuration	94
10.4.12.2	Legacy Console Redirection Settings Submenu	76	10.8	Save & Exit Menu.....	98
10.4.12.3	Console Redirection Settings Out-of-Band Management Submenu	76	11	Additional BIOS Features	99
10.4.13	CPU Submenu.....	77	11.1	BIOS Versions.....	99
10.4.13.1	Socket 0 CPU Information Submenu	78	11.2	Updating the BIOS.....	99
			11.3	Recovering from External Flash	100
			11.4	Supported Flash Devices	100

List of Tables

Table 1	COM Express™ 2.1 Pinout Types	12
Table 2	conga-TCA4 Variants	13
Table 3	Feature Summary	14
Table 4	Measurement Description.....	17
Table 5	Power Consumption Values	18
Table 6	CMOS Battery Power Consumption	18
Table 7	Cooling Solution Variants.....	21
Table 8	Display Combination	25
Table 9	Wake Events.....	38
Table 10	Signal Tables Terminology Descriptions	39
Table 11	Connector A-B Pinout.....	40
Table 12	Connector C-D Pinout	42
Table 13	PCI Express Signal Descriptions (general purpose)	44
Table 14	PCI Express Signal Descriptions (x16 Graphics).....	45
Table 15	DDI Signal Description.....	47
Table 16	TMDS Signal Descriptions	49
Table 17	DisplayPort (DP) Signal Descriptions	50
Table 18	CRT Signal Descriptions.....	51
Table 19	LVDS Signal Descriptions.....	52
Table 20	Serial ATA Signal Descriptions.....	53
Table 21	USB 2.0 Signal Descriptions.....	53
Table 22	USB 3.0 Signal Descriptions.....	54
Table 23	Gigabit Ethernet Signal Descriptions.....	55
Table 24	Intel® High Definition Audio Link Signals Descriptions.....	56
Table 25	ExpressCard Support Pins Descriptions.....	56
Table 26	LPC Signal Descriptions.....	56
Table 27	SPI BIOS Flash Interface Signal Descriptions.....	57
Table 28	Miscellaneous Signal Descriptions.....	57
Table 29	General Purpose I/O Signal Descriptions	58
Table 30	Power and System Management Signal Descriptions	58
Table 31	General Purpose Serial Interface Signal Descriptions	59
Table 32	Module Type Definition Signal Description	60
Table 33	Power and GND Signal Descriptions.....	61
Table 34	IO Space Ranges.....	62
Table 35	PCI Configuration Space Map	63
Table 36	PCI Interrupt Routing Map.....	64

Terminology

Term	Description
cBC	congatec Board Controller
DDC	Display Data Channel
eMMC	Embedded Multi-media Controller
GB	Gigabyte
Gbe	Gigabit Ethernet
GHz	Gigahertz
HDA	High Definition Audio
I/F	Interface
kB	Kilobyte
kHz	Kilohertz
LVDS	Low-Voltage Differential Signaling
MB	Megabyte
Mbit	Megabit
MHz	Megahertz
PCIe	PCI Express
SATA	Serial ATA
SoC	System On Chip
TBD	To be determined
TDP	Thermal Design Power
N.C.	Not connected
N.A.	Not available

1 Introduction

1.1 COM Express™ Concept

COM Express™ is an open industry standard defined specifically for COMs (computer on modules). Its creation provides the ability to make a smooth transition from legacy parallel interfaces to the newest technologies based on serial buses available today. COM Express™ modules are available in following form factors:

- Mini 84 mm x 55 mm
- Compact 95 mm x 95 mm
- Basic 125 mm x 95 mm
- Extended 155 mm x 110 mm

Table 1 COM Express™ 2.1 Pinout Types

Types	Connector Rows	PCIe Lanes	PCI	IDE	SATA Ports	LAN ports	USB 2.0/ USB 3.0	Display Interfaces
Type 1	A-B	Up to 6		-	4	1	8 / 0	VGA, LVDS
Type 2	A-B C-D	Up to 22	32 bit	1	4	1	8 / 0	VGA, LVDS, PEG/SDVO
Type 3	A-B C-D	Up to 22	32 bit	-	4	3	8 / 0	VGA, LVDS, PEG/SDVO
Type 4	A-B C-D	Up to 32		1	4	1	8 / 0	VGA, LVDS, PEG/SDVO
Type 5	A-B C-D	Up to 32		-	4	3	8 / 0	VGA, LVDS, PEG/SDVO
Type 6	A-B C-D	Up to 24		-	4	1	8 / 4*	VGA, LVDS/eDP, PEG, 3x DDI
Type 10	A-B	Up to 4		-	2	1	8 / 2	LVDS/eDP, 1x DDI

* The SuperSpeed USB ports (USB 3.0) are not in addition to the USB 2.0 ports. Up to 4 of the USB 2.0 ports can support SuperSpeed USB

The conga-TCA4 modules are based on the Type 6 pinout definition and comply with COM Express 2.1 specification. They are equipped with two high performance connectors that ensure stable data throughput.

The COM (computer on module) integrates all the core components and is mounted onto an application specific carrier board. COM modules are legacy-free design (no Super I/O, PS/2 keyboard and mouse) and provide most of the functional requirements for any application. These functions include, but are not limited to, a rich complement of contemporary high bandwidth serial interfaces such as PCI Express, Serial ATA, USB 2.0, and Gigabit Ethernet. The Type 6 pinout provides the ability to offer PCI Express, Serial ATA, and LPC options thereby expanding the range of potential peripherals. The robust thermal and mechanical concept, combined with extended power-management capabilities, is perfectly suited for all applications.

Carrier board designers can use as little or as many of the I/O interfaces as deemed necessary. The carrier board can therefore provide all the interface connectors required to attach the system to the application specific peripherals. This versatility allows the designer to create a dense and optimized package, which results in a more reliable product while simplifying system integration. Most importantly, COM Express™

modules are scalable, which means once an application has been created there is the ability to diversify the product range through the use of different performance class or form factor size modules. Simply unplug one module and replace it with another, no redesign is necessary.

1.2 Options Information

The conga-TCA4 is available in five variants. The table below shows the different configurations available.

Table 2 conga-TCA4 Variants

Part-No.	048310	048311	048312	048313	048314
Processor	Intel® Pentium® N3710 Quad Core 1.6/2.56 GHz	Intel® Celeron® N3160 Quad Core 1.6/2.24 GHz	Intel® Celeron® N3060 Dual Core 1.6/2.48 GHz	Intel® Celeron® N3010 Dual Core 1.04/2.24 GHz	Intel® Atom™ x5-E8000 Quad Core 1.04/2.00 GHz
L2 Cache	2 MB	2 MB	2 MB	2 MB	2 MB
Graphics	Intel® HD Graphic	Intel® HD Graphic	Intel® HD Graphic	Intel® HD Graphic	Intel® HD Graphic
GFX Normal/Burst	400/700	320/640	320/600	320/600	320
LVDS	Single/Dual 18/24 bit	Single/Dual 18/24 bit	Single/Dual 18/24 bit	Single/Dual 18/24 bit	Single/Dual 18/24 bit
DDI	DP++	DP++	DP++	DP++	DP++
Memory (DDR3L)	1600 MT/s dual channel	1600 MT/s dual channel	1600 MT/s dual channel	1600 MT/s dual channel	1600 MT/s dual channel
Max. TDP	6 W	6 W	6 W	4 W	5 W

2 Specifications

2.1 Feature List

Table 3 Feature Summary

Form Factor	Based on COM Express™ standard pinout Type 6, revision 2.1 (compact size 95 x 95 mm)	
Processor	Intel® Atom™, Pentium® and Celeron® Braswell SoC	
Memory	Two memory sockets (located on the top and bottom side of the conga-TCA4). Supports <ul style="list-style-type: none">- SO-DIMM non-ECC DDR3L modules- Data rates up to 1600 MT/s- Maximum 8 GB capacity	
Chipset	Integrated in SoC	
Onboard Storage	eMMC 4.51 onboard flash up to 64 GB	
Audio	High Definition Audio (HDA)/digital audio interface with support for multiple codecs	
Ethernet	Gigabit Ethernet via the onboard Intel® I211 Gigabit Ethernet controller	
Graphics Options	Intel® HD Graphics Gen. 8, full hardware acceleration for MPEG2, H.264/H.265/HEVC, DirectX11.1, OCL 1.2, OGL 4.2, WMV9 and VC1, VP8, JPEG, OpenGL ES, triple simultaneous display support Up to 3x DP++ ^{1,3} Up to 1x LVDS ^{1,2} 1x Optional eDP 1.4 ² Resolutions up to 4K	NOTE: ¹ The third DDI channel is only available if you do not use LVDS/eDP ² Either eDP or LVDS signals supported. Both are not supported. ³ The conga-TCA4 does not natively support TMDS. A DP++ to TMDS converter (e.g. PTN3360D) needs to be implemented
Peripheral Interfaces	2x SATA® up to 6Gb/s 5x PCI Express® Gen 2 with links up to 5.0 GT/s per lane 8x USB 2.0 (with up to 4x USB 3.0) 2x UART 1x SD/MMC	GPIOs muxed with SD card SPI Bus LPC Bus I²C Bus, multimaster
BIOS	AMI Aptio® V UEFI 2.x firmware; 8 MB serial SPI with congatec Embedded BIOS features (OEM Boot Logo, OEM Default Settings, LCD Control, Display Auto Detection, Backlight Control, Flash Update)	
Power Mgmt.	ACPI 5.0 compliant with battery support. Also supports Suspend to RAM (S3). Smart Battery Management. Intel AMT 11 Support	
congatec Board Controller	Multi-stage watchdog, non-volatile user data storage, manufacturing and board information, board statistics, BIOS setup data backup, I²C bus (fast mode, 400 kHz, multi-master), power loss control	



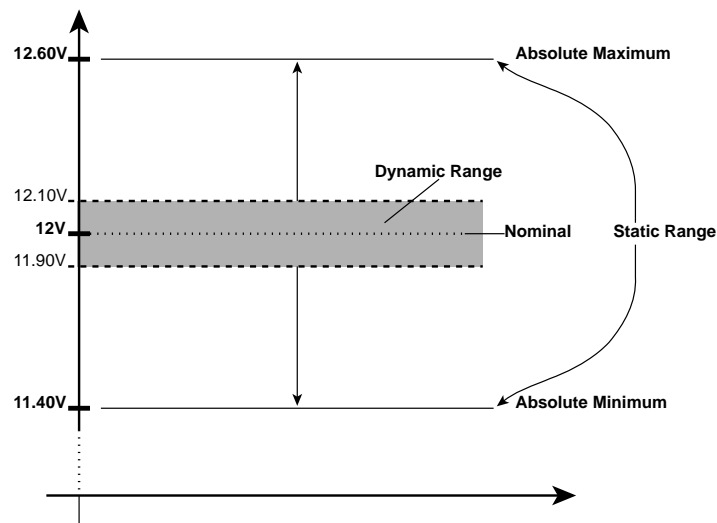
1. Optional features require customized conga-TCA4.

2. The conga-TCA4 supports only DDR3L memory modules.

2.4 Supply Voltage Standard Power

- 12V DC \pm 5%

The dynamic range shall not exceed the static range.



2.4.1 Electrical Characteristics

Power supply pins on the module's connectors limit the amount of input power. The following table provides an overview of the limitations for pinout Type 6 (dual connector, 440 pins).

Power Rail	Module Pin Current Capability (Ampere)	Nominal Input (Volts)	Input Range (Volts)	Derated Input (Volts)	Max. Input Ripple (10Hz to 20MHz) (mV)	Max. Module Input Power (w. derated input) (Watts)	Assumed Conversion Efficiency	Max. Load Power (Watts)
VCC_12V	12	12	11.4-12.6	11.4	+/- 100	137	85%	116
VCC_5V-SBY	2	5	4.75-5.25	4.75	+/- 50	9		
VCC_RTC	0.5	3	2.0-3.3		+/- 20			

2.4.2 Rise Time

The input voltages shall rise from 10% of nominal to 90% of nominal at a minimum slope of 250V/s. The smooth turn-on requires that during the 10% to 90% portion of the rise time, the slope of the turn-on waveform must be positive.

2.5 Power Consumption

The power consumption values were measured with the following setup:

- Input voltage +12 V
- conga-TCA4 COM
- modified congatec carrier board
- conga-TCA4 cooling solution
- Microsoft Windows 7 (64-bit)



Note

The CPU was stressed to its maximum workload.

Table 4 Measurement Description

The power consumption values were recorded during the following system states:

System State	Description	Comment
S0: Minimum value	Lowest frequency mode (LFM) with minimum core voltage during desktop idle	The CPU was stressed to its maximum frequency
S0: Maximum value	Highest frequency mode (HFM/Turbo Boost)	The CPU was stressed to its maximum frequency
S0: Peak value	Highest current spike during the measurement of "S0: Maximum value". This state shows the peak value during runtime	Consider this value when designing the system's power supply to ensure that sufficient power is supplied during worst case scenarios
S3	COM is powered by VCC_5V_SBY	
S5	COM is powered by VCC_5V_SBY	



Note

1. *The fan and SATA drives were powered externally.*
2. *All other peripherals except the LCD monitor were disconnected before measurement.*

Table 5 Power Consumption Values

The table below provides additional information about the conga-TCA4 power consumption. The values are recorded at various operating mode.

Part No.	Memory Size	H.W Rev.	BIOS Rev.	OS (64-bit)	CPU			Current (A)				
					Variant	Cores	Freq/Turbo (GHz)	S0:Min	S0: Max	S0: Peak	S3	S5
048310	2 x 2 GB	A.0	TA40R012	Windows 7	Intel® Pentium® N3710	4	1.60 / 2.56	0.30	1.33	1.68	0.15	0.16
048311	2 x 2 GB	A.1	TA40R012	Windows 7	Intel® Celeron® N3160	4	1.60 / 2.24	0.30	1.31	1.57	0.16	0.17
048312	2 x 2 GB	A.1	TA40R012	Windows 7	Intel® Celeron® N3060	2	1.60 / 2.48	0.30	1.02	1.19	0.17	0.17
048313	2 x 2 GB	A.1	TA40R012	Windows 7	Intel® Celeron® N3010	2	1.04 / 2.24	0.32	0.88	1.13	0.15	0.16
048314	2 x 2 GB	A.1	TA40R012	Windows 7	Intel® Atom™ x5-E8000	4	1.04 / 2.00	0.30	0.92	0.97	0.20	0.20



Note
With fast input voltage rise time, the inrush current may exceed the measured peak current.

2.6 Supply Voltage Battery Power

Table 6 CMOS Battery Power Consumption

RTC @	Voltage	Current
-10°C	3V DC	1.36 µA
20°C	3V DC	1.59 µA
70°C	3V DC	2.57 µA



1. Do not use the CMOS battery power consumption value listed above to calculate CMOS battery lifetime.
2. Measure the CMOS battery power consumption of your application in worst case conditions (for example, during high temperature and high battery voltage).
3. Consider the self-discharge of the battery when calculating the lifetime of the CMOS battery. For more information, refer to application note AN9_RTC_Battery_Lifetime.pdf on congatec GmbH website at www.congatec.com/support/application-notes.
4. We recommend to always have a CMOS battery present when operating the conga-TCA4.

2.7 Environmental Specifications

Temperature (commercial variants)

Operation: 0° to 60°C

Storage: -20° to +80°C

Humidity

Operation: 10% to 90%

Storage: 5% to 95%



Caution

The above operating temperatures must be strictly adhered to at all times. When using a congatec heatspreader, the maximum operating temperature refers to any measurable spot on the heatspreader's surface.

Humidity specifications are for non-condensing conditions.

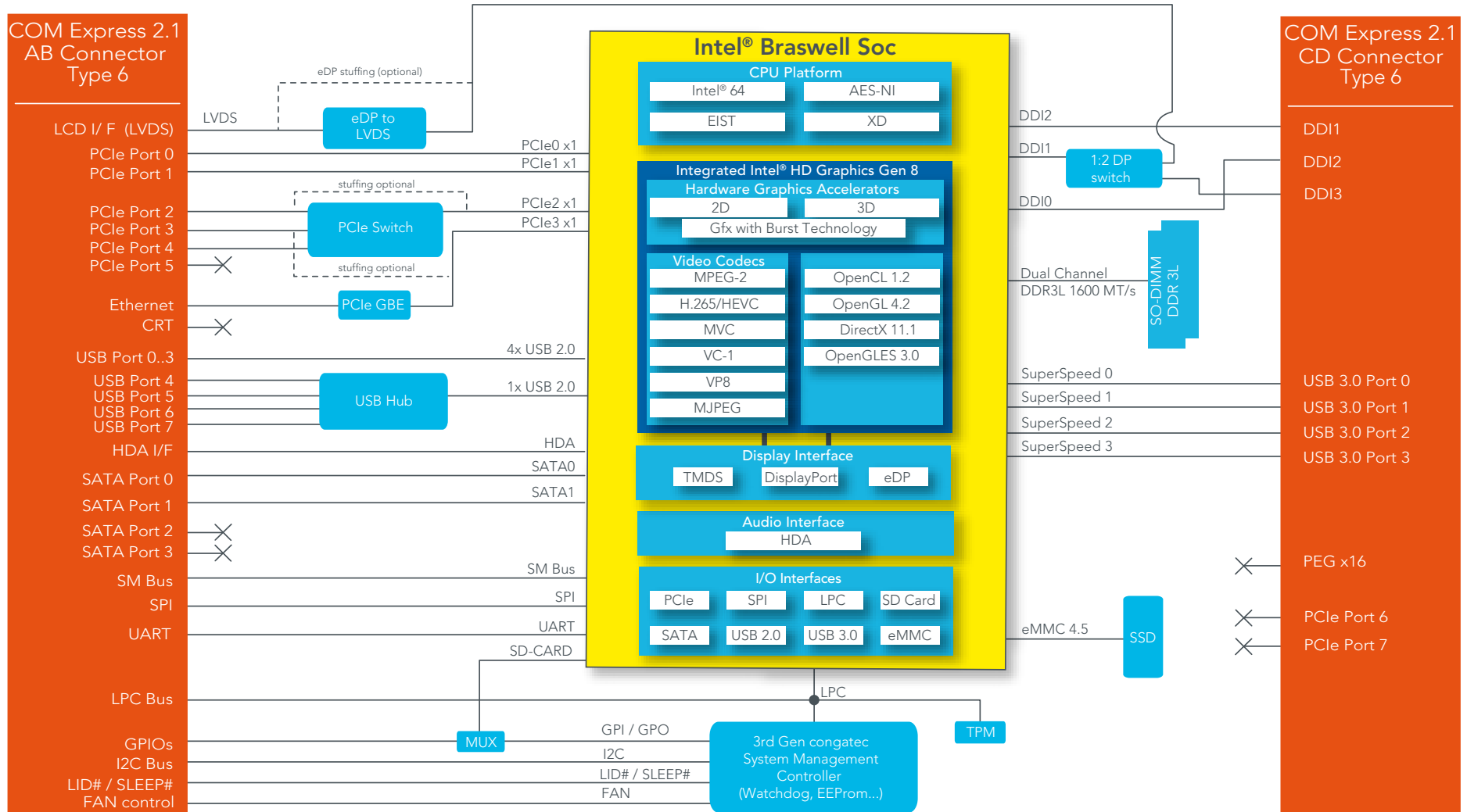


Note

For long term storage of the conga-TCA4 (more than six months), keep the conga-TCA4 in a climate-controlled building at a constant temperature between 5°C and 40°C, with humidity of less than 65% and at an altitude of less than 3000 m. Also ensure the storage location is dry and well ventilated.

We do not recommend storing the conga-TCA4 for more than five years under these conditions.

3 Block Diagram



4 Cooling Solutions

congatec GmbH offers the following cooling solutions for the conga-TCA4. The dimensions of the cooling solutions are shown in the sub-sections. All measurements are in millimeters.

Table 7 Cooling Solution Variants

	Cooling Solution	Part No.	Description
1	HSP	047350	Standard heatspreader with M2.5 mm threaded standoffs
		047351	Standard heatspreader with 2.7 mm bore-hole standoffs
2	CSP	047352	Standard passive cooling solution with M2.5 mm threaded standoffs
		047353	Standard passive cooling solution with 2.7 mm bore-hole standoffs



Note

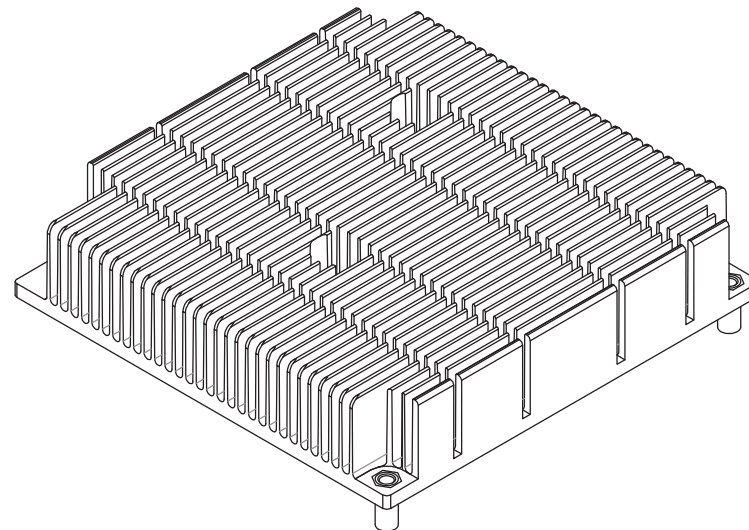
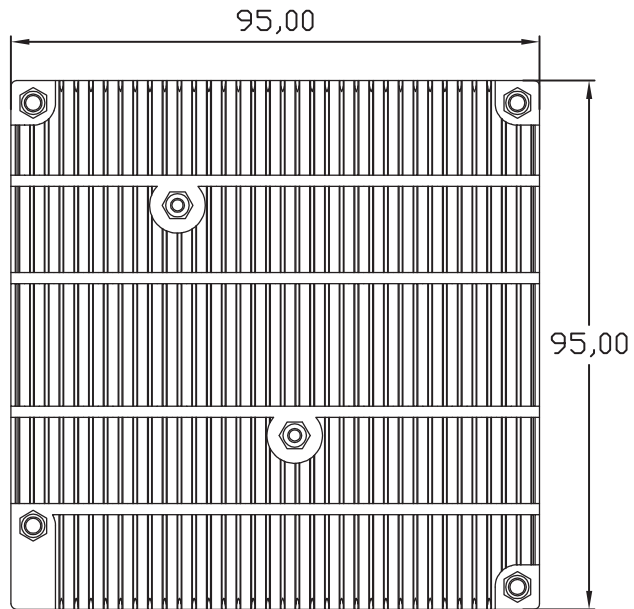
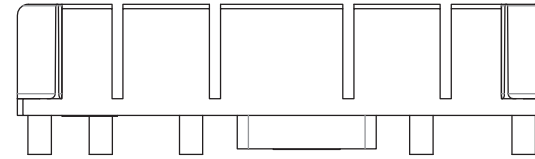
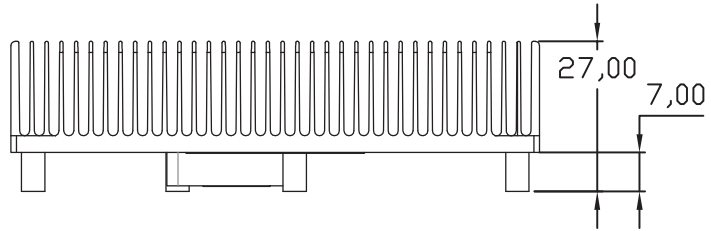
1. We recommend a maximum torque of 0.4 Nm for carrier board mounting screws and 0.5 Nm for module mounting screws.
2. The gap pad material used on congatec heatspreaders may contain silicon oil that can seep out over time depending on the environmental conditions it is subjected to. For more information about this subject, contact your local congatec sales representative and request the gap pad material manufacturer's specification.
3. For optimal thermal dissipation, do not store the congatec cooling solutions for more than six months.



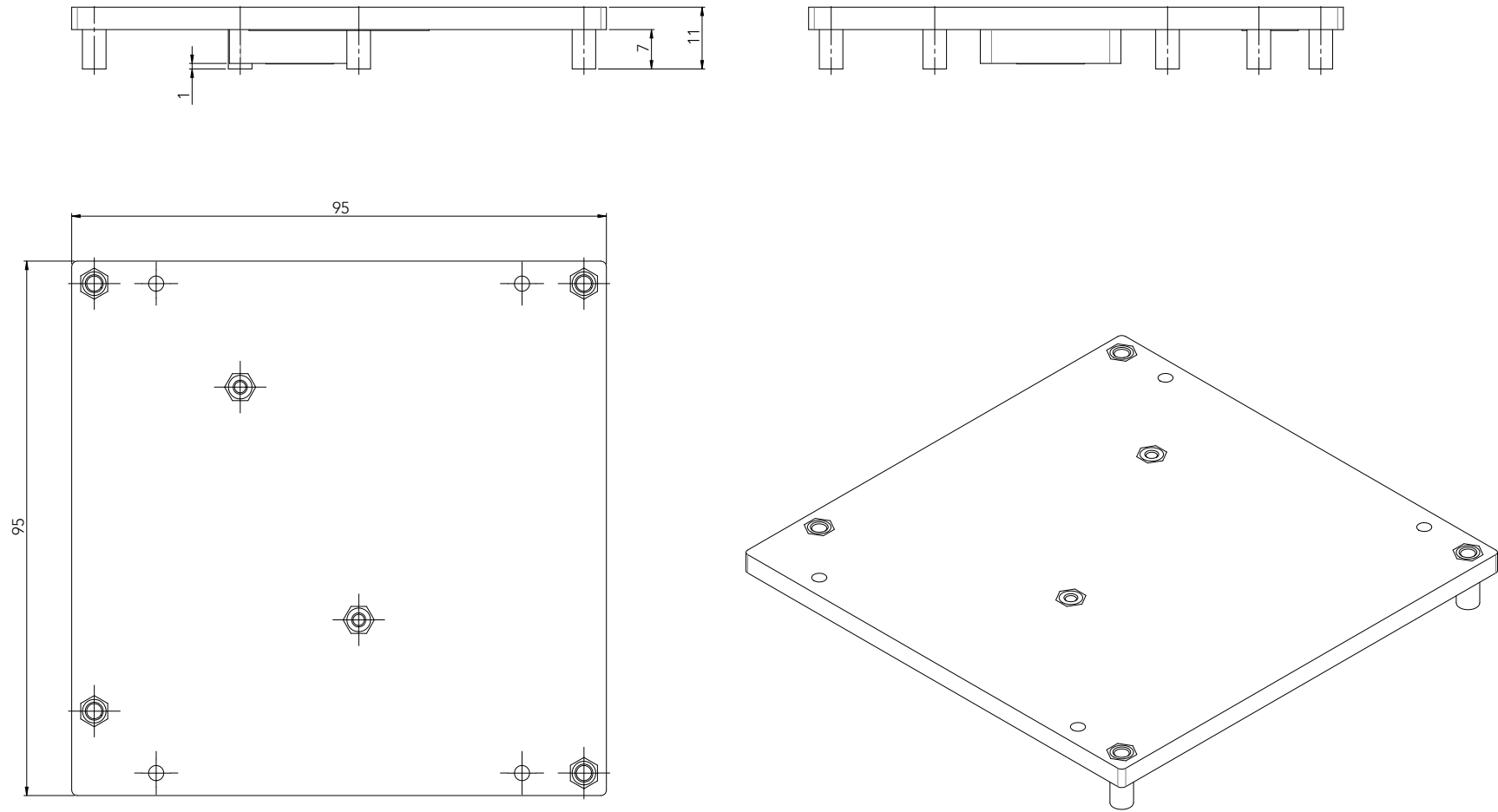
Caution

1. The congatec heatspreaders/cooling solutions are tested only within the commercial temperature range of 0° to 60°C. Therefore, if your application that features a congatec heatspreader/cooling solution operates outside this temperature range, ensure the correct operating temperature of the module is maintained at all times. This may require additional cooling components for your final application's thermal solution.
2. For adequate heat dissipation, use the mounting holes on the cooling solution to attach it to the module. Apply thread-locking fluid on the screws if the cooling solution is used in a high shock and/or vibration environment. To prevent the standoff from stripping or cross-threading, use non-threaded carrier board standoffs to mount threaded cooling solutions.
3. For applications that require vertically-mounted cooling solution, use only coolers that secure the thermal stacks with fixing post. Without the fixing post feature, the thermal stacks may move.
4. Do not exceed the recommended maximum torque. Doing so may damage the module or the carrier board, or both.

4.1 CSP Dimensions



4.2 HSP Dimensions



5 Connector Rows

The conga-TCA4 is connected to the carrier board via two 220-pin connectors (COM Express Type 6 pinout). These connectors are broken down into four rows. The primary connector consists of rows A and B while the secondary connector consists of rows C and D.

5.1 Primary and Secondary Connector Rows

The following subsystems can be found on the primary and secondary connector rows.

5.1.1 PCI Express™

The conga-TCA4 offers five PCI Express™ lanes on the A-B connector. The lanes support:

- up to 5 GT/s (Gen 2) speed
- a 5 x1 link configuration
- an optional 1 x2 + 3 x1 link configuration (requires a special/customized BIOS firmware)

5.1.2 Display Interfaces

The conga-TCA4 supports:

- up to three DP++
- single- or dual-channel LVDS
- up to three independent displays



Note

1. The third DDI interface (DP++) is multiplexed with the LVDS interface and configurable via the BIOS setup menu.
2. The conga-TCA4 supports only two DP++ if LVDS is selected.

The table below shows the conga-TCA4 display combinations.

Table 8 Display Combination

Display 1	Display 2	Display 3	Display 1 (Max. Resolution)	Display 2 (Max. Resolution)	Display 3 (Max. Resolution)
DP++	DP++	LVDS /eDP	3840x2160 @ 30 Hz	3840x2160 @ 30 Hz	1920x1200 @ 60Hz (LVDS) 2560 x 1440 @ 60Hz (eDP)
DP++	DP++	DP++	3840x2160 @ 30 Hz	3840x2160 @ 30 Hz	3840x2160 @ 30Hz

5.1.2.1 DisplayPort (DP)

The conga-TCA4 supports the following:

- up to three DP ports (two DP ports by default)
- VESA DisplayPort Standard 1.1a
- up to 3840x2160 at 30 Hz
- maximum of three independent DP displays



Note
Only two DP ports are available if LVDS is supported.

5.1.2.2 LVDS

The conga-TCA4 offers an LVDS interface on the A-B connector rows. The interface is provided by routing the onboard PTN3460 to the SoC's second Digital Display Interface, via a DisplayPort switch.

With the integration of the switch, the conga-TCA4 can be configured in the BIOS to support either LVDS on the A-B connector or a third Digital Display Interface on the C-D connector.

The LVDS interface supports:

- single or dual channel LVDS (color depths of 18 bpp or 24 bpp)
- integrated flat panel interface with clock frequency up to 112 MHz
- VESA and OpenLDI LVDS color mappings

-
- automatic panel detection via Embedded Panel Interface based on VESA EDID™ 1.4
 - resolution up to 1920x1200 in dual LVDS bus mode

**Note**

The LVDS interface is available only if the optional COM Express Digital Display Interface (DDI3) is not used.

5.1.3 USB 2.0

The conga-TCA4 offers up to eight USB 2.0 interfaces on the A–B connector and four SuperSpeed differential signals on the C–D connector. The xHCI host controller supports the following:

- USB 3.0 Specification
- SuperSpeed, High-Speed, Full-Speed and Low-Speed USB signaling
- data transfers of up to 5 Gbps for USB 3.0 ports

**Note**

The USB 3.0 ports should be paired with USB 2.0 ports 0...3 on the carrier board.

5.1.4 SATA

The conga-TCA4 offers two SATA interfaces (SATA 0-1) on the A-B connector. The interfaces support:

- independent DMA operation
- data transfer rates up to 6.0 Gbps
- AHCI mode
- Hot-plug detect

5.1.5 Gigabit Ethernet

The conga-TCA4 offers a Gigabit Ethernet interface on connector rows A-B via the onboard Intel® I211 Gigabit Ethernet controller. This controller is connected to the Intel® Braswell SoC through the fourth PCI Express lane.

The interface supports full-duplex operation at 10/100/1000 Mbps and half-duplex operation at 10/100 Mbps.

5.1.6 High Definition Audio (HDA) Interface

The conga-TCA4 supports HDA audio codecs.

5.1.7 LPC Bus

The conga-TCA4 offers the LPC (Low Pin Count) bus. The LPC bus corresponds approximately to a serialized ISA bus yet with a significantly reduced number of signals and functionality. Due to the software compatibility to the ISA bus, I/O extensions such as additional serial ports can be easily implemented on an application specific carrier board using this bus. Only certain devices such as Super I/O or TPM 1.2 and TPM 2.0 chips can be implemented on the carrier board. See section 9.1.1 for more information about the LPC Bus



Note

All conga-TCA4 CPUs run the LPC bus at 25MHz.

5.1.8 I²C Bus

The I²C bus is implemented through the congatec board controller. The controller provides a multi-master capable bus that runs at fast mode.

5.1.9 ExpressCard™

The conga-TCA4 supports the implementation of ExpressCards, which require the dedication of one USB port and a x1 PCI Express link for each ExpressCard used.

5.1.10 SPI

The conga-TCA4 supports SPI interface. This interface makes it possible to boot from an external SPI flash (alternative interface for the BIOS flash device).

5.1.11 SD Card

The conga-TCA4 offers a 4-bit SD interface for SD/MMC cards on the A-B connector. The SD signals are multiplexed with GPIO signals and controlled by the congatec Board controller. The SD card controller in the Storage Control Cluster of the SoC supports the SD interface with up to 832 Mb/s data rate using 4 parallel data lines.

5.1.12 General Purpose Serial Interface (UART)

The conga-TCA4 offers two UART interface. The pins are designated SER0_TX, SER0_RX, SER1_TX and SER1_RX. Data out of the module is on the _TX pins. Hardware handshaking and hardware flow control signals are not supported.

5.1.13 Power Control

PWR_OK

Power OK from main power supply or carrier board voltage regulator circuitry. A high value indicates that the power is good and the module can start its onboard power sequencing. Carrier board hardware must drive this signal low until all power rails and clocks are stable. Releasing PWR_OK too early or not driving it low at all can cause numerous boot up problems. It is a good design practice to delay the PWR_OK signal a little (typically 100ms) after all carrier board power rails are up, to ensure a stable system. See screenshot below.



Note

The module is kept in reset as long as the PWR_OK is driven by carrier board hardware.

The conga-TCA4 provides support for controlling ATX-style power supplies. When not using an ATX power supply then the conga-TCA4's pins SUS_S3/PS_ON, 5V_SB, and PWRBTN# should be left unconnected.

SUS_S3#/PS_ON#

The SUS_S3#/PS_ON# (pin A15 on the A-B connector) signal is an active-low output that can be used to turn on the main outputs of an ATX-style power supply. In order to accomplish this the signal must be inverted with an inverter/transistor that is supplied by standby voltage and is located on the carrier board.

PWRBTN#

When using ATX-style power supplies PWRBTN# (pin B12 on the A-B connector) is used to connect to a momentary-contact, active-low debounced push-button input while the other terminal on the push-button must be connected to ground. This signal is internally pulled up to 3V_SB using a 10k resistor. When PWRBTN# is asserted it indicates that an operator wants to turn the power on or off. The response to this signal from the system may vary as a result of modifications made in BIOS settings or by system software.

Power Supply Implementation Guidelines

12 V input power is the sole operational power source for the conga-TCA4. Other required voltages are generated internally on the module using onboard voltage regulators



Note

When designing a power supply for a conga-TCA4 application, be aware that the system may malfunction when a 12 V power supply that produces non-monotonic voltage is used to power the system up. Though this problem is rare, it has been observed in some mobile power supply applications.

This problem occurs because some internal circuits on the module (e.g. clock-generator chips) generate their own reset signals when the supply voltage exceeds a certain voltage threshold. A voltage dip after passing this threshold may lead to these circuits becoming confused, thereby resulting in a malfunction.

To ensure this problem does not occur, observe the power supply rise waveform through an oscilloscope during the power supply qualification phase. This will help to determine if the rise is indeed monotonic and does not have any dips. For more information, see the "Power Supply Design Guide for Desktop Platform Form Factors" document at www.intel.com.

5.1.14 Power Management

ACPI 5.0 compliant with battery support. Also supports Suspend to RAM (S3).

6 Additional Features

6.1 eMMC

The conga-TCA4 offers eMMC 4.51 flash (compatible with rev. 4.5) onboard the Intel Pentium/Celeron variants, with up to 64 GB capacity. Changes to the onboard eMMC may occur during the lifespan of the module in order to keep up with the rapidly changing eMMC technology.

The performance of the newer eMMC may vary depending on the eMMC technology.



Note

For adequate operation of the eMMC, ensure that at least 15 % of the eMMC storage is reserved for vendor-specific functions. "

6.2 Low Voltage Memory (DDR3L)

The Braswell SoC on the conga-TCA4 supports low voltage system memory interface. The memory interface I/O voltage is 1.35V and supports unbuffered DDR3L SO-DIMMs. With this low voltage system memory interface on the processor, the conga-TCA4 offers a system optimized for lowest possible power consumption. The reduction in power consumption due to lower voltage subsequently reduces the heat generated.



Note

- 1. The conga-TCA4 supports only DDR3L memory modules.*
- 2. The memory modules in the sockets must be symmetrical - that is, same raw cards and same memory sizes. Therefore, do not use different memory modules in the memory sockets. Doing so may cause system instability or memory errors. Also make sure the memory modules support the data transfer rate of the particular variant.*
- 3. When using one memory socket, insert the memory module only in the first memory slot on the conga-TCA4 (top side). If the first memory slot is empty, the SoC on the conga-TCA4 ignores the second memory socket (bottom side). When this happens, the conga-TCA4 does not start. See the Intel's Braswell datasheet for more information.*

6.3 congatec Board Controller (cBC)

The conga-TCA4 is equipped with a Texas Instruments Tiva™ TM4E1231H6ZRBI microcontroller. This onboard microcontroller plays an important role for most of the congatec BIOS features. It fully isolates some of the embedded features such as system monitoring or the I²C bus from the x86 core architecture, which results in higher embedded feature performance and more reliability, even when the x86 processor is in a low power mode. It also ensures that the congatec embedded feature set is fully compatible amongst all congatec modules.

6.3.1 Board Information

The cBC provides a rich data-set of manufacturing and board information such as serial number, EAN number, hardware and firmware revisions, and so on. It also keeps track of dynamically changing data like runtime meter and boot counter.

6.3.2 General Purpose Input/Output

The conga-TCA4 offers general purpose inputs and outputs for custom system design. These GPIOs are multiplexed with SD signals and are controlled by the cBC.

6.3.3 Fan Control

The conga-TCA4 has additional signals and functions to further improve system management. One of these signals is an output signal called FAN_PWMOUT that allows system fan control using a PWM (Pulse Width Modulation) output. Additionally, there is an input signal called FAN_TACHOIN that provides the ability to monitor the system's fan RPMs (revolutions per minute). This signal must receive two pulses per revolution in order to produce an accurate reading. For this reason, a two pulse per revolution fan or similar hardware solution is recommended.



Note

A four-wire fan must be used to generate the correct speed readout.

The congatec COM Express Type 6 and Type 10 modules use a Push-Pull output for the fan_pwm signal instead of the open drain output specified in the COM Express specification. Although this does not comply with the COM Express specification 2.0, the benefits are obvious. The Push-Pull output optimizes the power consumed by the fan_pwm signal without functional change.

6.3.4 Power Loss Control

The cBC provides the power loss control feature. The power loss control feature determines the behaviour of the system after an AC power loss occurs. This feature applies to systems with ATX-style power supplies which support standby power rail.

The term “power loss” implies that all power sources, including the standby power are lost (G3 state). Once power loss (transition to G3) or shutdown (transition to S5) occurs, the board controller continuously monitors the standby power rail. If the standby voltage remains stable for 30 seconds, the cBC assumes the system was switched off properly. If the standby voltage is no longer detected within 30 seconds, the module considers this an AC power loss condition.

The power loss control feature has three different modes that define how the system responds when standby power is restored after a power loss occurs. The modes are:

- Turn On: The system is turned on after a power loss condition
- Remain Off: The system is kept off after a power loss condition
- Last State: The board controller restores the last state of the system before the power loss condition



Note

1. If a power loss condition occurs within 30 seconds after a regular shutdown, the cBC may incorrectly set the last state to “ON”.
2. The settings for power loss control have no effect on systems with AT-style power supplies which do not support standby power rail.
3. The 30 seconds monitoring cycle applies only to the “Last State” power loss control mode.

6.3.5 Watchdog

The conga-TCA4 is equipped with a multi-stage watchdog solution that is triggered by software. The COM Express™ Specification does not provide support for external hardware triggering of the Watchdog, which means the conga-TCA4 does not support external hardware triggering.

For more information about the Watchdog feature see the BIOS setup description section 10.4.1 of this document and application note AN3_Watchdog.pdf on the congatec GmbH website at www.congatec.com.



Note

The conga-TCA4 module does not support the watchdog NMI mode. COM Express type 6 modules do not support the PCI bus and therefore the PCI_SERR# signal is not available. There is no way to drive a NMI to the processor without the presence of the PCI_SERR# PCI bus signal.

6.3.6 I²C Bus

The conga-TCA4 supports I²C bus. Thanks to the I²C host controller in the cBC the I²C bus is multimaster capable and runs at fast mode.

6.4 OEM BIOS Customization

The conga-TCA4 is equipped with congatec Embedded BIOS, which is based on American Megatrends Inc. Aptio UEFI firmware. The congatec Embedded BIOS allows system designers to modify the BIOS. For more information about customizing the congatec Embedded BIOS, refer to the congatec System Utility user's guide CGUTLm1x.pdf on the congatec website at www.congatec.com or contact technical support.

The customization features supported are described below.

6.4.1 OEM Default Settings

This feature allows system designers to create and store their own BIOS default configuration. Customized BIOS development by congatec for OEM default settings is no longer necessary because customers can easily perform this configuration by themselves using the congatec system utility CGUTIL.

See congatec application note AN8_Create_OEM_Default_Map.pdf on the congatec website for details on how to add OEM default settings to the congatec Embedded BIOS.

6.4.2 OEM Boot Logo

This feature allows system designers to replace the standard text output displayed during POST with their own BIOS boot logo. Customized BIOS development by congatec for OEM Boot Logo is no longer necessary because customers can easily perform this configuration by themselves using the congatec system utility CGUTIL. See congatec application note AN8_Create_And_Add_Bootlogo.pdf on the congatec website for details on how to add OEM boot logo to the congatec Embedded BIOS.

6.4.3 OEM POST Logo

This feature allows system designers to replace the congatec POST logo displayed in the upper left corner of the screen during BIOS POST with their own BIOS POST logo. Use the congatec system utility CGUTIL 1.5.4 or later to replace/add the OEM POST logo.

6.4.4 OEM BIOS Code/Data

With the congatec embedded BIOS it is possible for system designers to add their own code to the BIOS POST process. The congatec Embedded BIOS first calls the OEM code before handing over control to the OS loader.

Except for custom specific code, this feature can also be used to support Win XP SLP installation, Window 7 SLIC table (OA2.0), Windows 8 OEM activation (OA3.0), verb tables for HDA codecs, PCI/PCIe opROMs, bootloaders, rare graphic modes and Super I/O controller initialization.



The OEM BIOS code of the new UEFI based firmware is only called when the CSM (Compatibility Support Module) is enabled in the BIOS setup menu. Contact congatec technical support for more information on how to add OEM code.

6.4.5 OEM DXE Driver

This feature allows designers to add their own UEFI DXE driver to the congatec embedded BIOS. Contact congatec technical support for more information on how to add an OEM DXE driver.

6.5 congatec Battery Management Interface

To facilitate the development of battery powered mobile systems based on embedded modules, congatec GmbH defined an interface for the exchange of data between a CPU module (using an ACPI operating system) and a Smart Battery system. A system developed according to the congatec Battery Management Interface Specification can provide the battery management functions supported by an ACPI capable operating system (for example, charge state of the battery, information about the battery, alarms/events for certain battery states and so on) without the need for additional modifications to the system BIOS.

In addition to the ACPI-Compliant Control Method Battery, the latest versions of the conga-TCA4 BIOS and board controller firmware also support LTC1760 battery manager from Linear Technology and a battery-only solution (no charger). All three battery solutions are supported on the I2C bus and the SMBus. This gives the system designer more flexibility when choosing the appropriate battery sub-system.

For more information about the supported Battery Management Interface, contact your local sales representative.

6.6 API Support (CGOS/EAPI)

To benefit from the above mentioned non-industry standard feature set, congatec provides an API that allows application software developers to easily integrate all these features into their code. The CGOS API (congatec Operating System Application Programming Interface) is the congatec proprietary API that is available for all commonly used Operating Systems such as Win32, Win64, Win CE, Linux.

The architecture of the CGOS API driver provides the ability to write application software that runs unmodified on all congatec CPU modules. All the hardware related code is contained within the congatec embedded BIOS on the module. See section 1.1 of the CGOS API software developers guide, which is available on the congatec website.

6.7 Security Features

The conga-TCA4 can be equipped optionally with a “Trusted Platform Module” (TPM1.2 and TPM 2.0). This includes co-processors to calculate efficient hash and RSA algorithms with key lengths up to 2,048 bits as well as a real random number generator. Security sensitive applications like gaming and e-commerce will benefit also with improved authentication, integrity and confidence levels.

6.8 Suspend to Ram

The Suspend to RAM feature is available on the conga-TCA4.

7 conga Tech Notes

The conga-TCA4 has some technological features that require additional explanation. The following section will give the reader a better understanding of some of these features. This information will also help to gain a better understanding of the information found in the system resources section of this user's guide as well as some of the setup nodes found in the BIOS Setup Program description section.

7.1 Intel Braswell SoC Features

7.1.1 Processor Core

The Soc features Dual or Quad Out-of-Order Execution processor cores. The cores are grouped into Dual-Core modules with each module sharing a 1 MB L2 cache (512 KB per core). Some of the features supported by the core are:

- Intel 64 architecture
- Intel Streaming SIMD Extensions
- Support for Intel VT-x
- Thermal management support via Intel Thermal Monitor
- Uses Power Aware Interrupt Routing
- Uses 14 nm process technology



Note

Intel Hyper-Threading technology is not supported (four cores execute four threads)

7.1.1.1 Intel Virtualization Technology

Intel® Virtualization Technology (Intel® VT) makes a single system appear as multiple independent systems to software. This allows multiple, independent operating systems to run simultaneously on a single system. Intel® VT comprises technology components to support virtualization of platforms based on Intel architecture microprocessors and chipsets. Intel® Virtualization Technology for IA-32, Intel® 64 and Intel® Architecture (Intel® VT-x) added hardware support in the processor to improve the virtualization performance and robustness.

RTS Real-Time Hypervisor supports Intel VT and is verified on all current congatec x86 hardware.



Note

congatec supports RTS Hypervisor.

7.1.1.2 Thermal Management

ACPI is responsible for allowing the operating system to play an important part in the system's thermal management. This results in the operating system having the ability to take control of the operating environment by implementing cooling decisions according to the demands put on the CPU by the application.

The conga-TCA4 ACPI thermal solution offers two different cooling policies.

- **Passive Cooling**

When the temperature in the thermal zone must be reduced, the operating system can decrease the power consumption of the processor by throttling the processor clock. One of the advantages of this cooling policy is that passive cooling devices (in this case the processor) do not produce any noise. Use the "passive cooling trip point" setup node in the BIOS setup program to determine the temperature threshold that the operating system will use to start or stop the passive cooling procedure.

- **Critical Trip Point**

If the temperature in the thermal zone reaches a critical point then the operating system will perform a system shut down in an orderly fashion in order to ensure that there is no damage done to the system as result of high temperatures. Use the "critical trip point" setup node in the BIOS setup program to determine the temperature threshold that the operating system will use to shut down the system.



The end user must determine the cooling preferences for the system by using the setup nodes in the BIOS setup program to establish the appropriate trip points.

If passive cooling is activated and the processor temperature is above the trip point the processor clock is throttled. See section 12 of the ACPI Specification 2.0 C for more information about passive cooling.

7.2 ACPI Suspend Modes and Resume Events

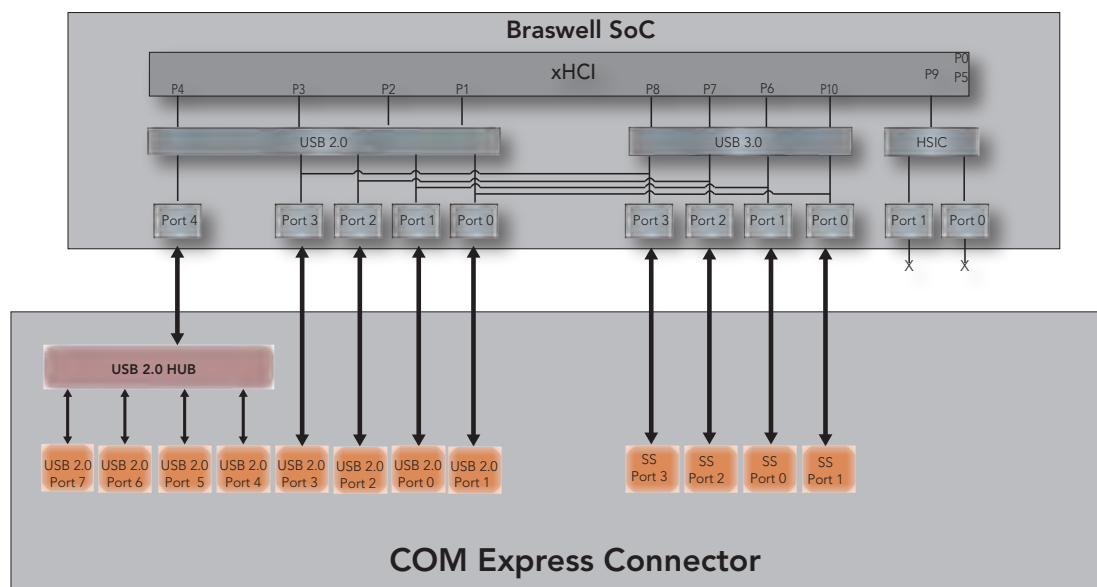
The conga-TCA4 BIOS supports S3 (Suspend to RAM). The BIOS does not support S4 (Suspend to Disk).

Table 9 Wake Events

The table below lists the events that wake the system from S3.

Wake Event	Conditions/Remarks
Power Button	Wakes unconditionally from S3-S5
Onboard LAN Event	Device driver must be configured for Wake On LAN support
PCI Express WAKE#	Wakes unconditionally from S3-S5
PME#	Activate the wake up capabilities of a PCI device using Windows Device Manager configuration options for this device or enable Resume On PME# in the Power setup menu
USB Mouse/Keyboard Event	When Standby mode is set to S3, USB hardware must be powered by standby power source. Set USB Device Wakeup from S3/S4 to ENABLED in the ACPI setup menu (if setup node is available in BIOS setup program). In Device Manager look for the keyboard/ mouse devices. Go to the Power Management tab and check 'Allow this device to bring the computer out of standby'
RTC Alarm	Activate and configure Resume On RTC Alarm in the Power setup menu. Only available in S5
Watchdog Power Button Event	Wakes unconditionally from S3-S5

7.3 USB Port Mapping



8 Signal Descriptions and Pinout Tables

The following section describes the signals found on the conga-TCA4. The pinout of the modules complies with COM Express Type 6, rev. 2.1.

The table below describes the terminology used in this section. The PU/PD column indicates if a COM Express™ module pull-up or pull-down resistor has been used. If the field entry area in this column for the signal is empty, then no pull-up or pull-down resistor has been implemented by congatec.

The “#” symbol at the end of the signal name indicates that the active or asserted state occurs when the signal is at a low voltage level. When “#” is not present, the signal is asserted when at a high voltage level.



Note

The Signal Description tables do not list internal pull-ups or pull-downs implemented by the chip vendors. Only pull-ups or pull-downs implemented by congatec are listed. For information about the internal pull-ups or pull-downs implemented by the chip vendors, refer to the respective chip's datasheet.

Table 10 Signal Tables Terminology Descriptions

Term	Description
PU	congatec implemented pull-up resistor
PD	congatec implemented pull-down resistor
I/O 3.3V	Bi-directional signal 3.3V tolerant
I/O 5V	Bi-directional signal 5V tolerant
I 3.3V	Input 3.3V tolerant
I 5V	Input 5V tolerant
I/O 3.3VSB	Input 3.3V tolerant active in standby state
O 3.3V	Output 3.3V signal level
O 5V	Output 5V signal level
OD	Open drain output
P	Power Input/Output
DDC	Display Data Channel
PCIE	In compliance with PCI Express Base Specification, Revision 1.0a
SATA	In compliance with Serial ATA specification, Revision 3.0
REF	Reference voltage output. May be sourced from a module power plane
PDS	Pull-down strap. A module output pin that is either tied to GND or is not connected. Used to signal module capabilities (pinout type) to the Carrier Board.

8.1 Connector Signal Descriptions

Table 11 Connector A-B Pinout

Pin	Row A	Pin	Row B	Pin	Row A	Pin	Row B
A1	GND (FIXED)	B1	GND (FIXED)	A56	PCIE_TX4-	B56	PCIE_RX4-
A2	GBE0_MDI3-	B2	GBE0_ACT#	A57	GND	B57	GPO2
A3	GBE0_MDI3+	B3	LPC_FRAME#	A58	PCIE_TX3+	B58	PCIE_RX3+
A4	GBE0_LINK100#	B4	LPC_AD0	A59	PCIE_TX3-	B59	PCIE_RX3-
A5	GBE0_LINK1000#	B5	LPC_AD1	A60	GND (FIXED)	B60	GND (FIXED)
A6	GBE0_MDI2-	B6	LPC_AD2	A61	PCIE_TX2+	B61	PCIE_RX2+
A7	GBE0_MDI2+	B7	LPC_AD3	A62	PCIE_TX2-	B62	PCIE_RX2-
A8	GBE0_LINK#	B8	LPC_DRQ0# (*)	A63	GPI1	B63	GPO3
A9	GBE0_MDI1-	B9	LPC_DRQ1# (*)	A64	PCIE_TX1+	B64	PCIE_RX1+
A10	GBE0_MDI1+	B10	LPC_CLK	A65	PCIE_TX1-	B65	PCIE_RX1-
A11	GND (FIXED)	B11	GND (FIXED)	A66	GND	B66	WAKE0#
A12	GBE0_MDI0-	B12	PWRBTN#	A67	GPI2	B67	WAKE1#
A13	GBE0_MDI0+	B13	SMB_CK	A68	PCIE_TX0+	B68	PCIE_RX0+
A14	GBE0_CTREF (*)	B14	SMB_DAT	A69	PCIE_TX0-	B69	PCIE_RX0-
A15	SUS_S3#	B15	SMB_ALERT#	A70	GND (FIXED)	B70	GND (FIXED)
A16	SATA0_TX+	B16	SATA1_TX+	A71	LVDS_A0+	B71	LVDS_B0+
A17	SATA0_TX-	B17	SATA1_TX-	A72	LVDS_A0-	B72	LVDS_B0-
A18	SUS_S4#	B18	SUS_STAT#	A73	LVDS_A1+	B73	LVDS_B1+
A19	SATA0_RX+	B19	SATA1_RX+	A74	LVDS_A1-	B74	LVDS_B1-
A20	SATA0_RX-	B20	SATA1_RX-	A75	LVDS_A2+	B75	LVDS_B2+
A21	GND (FIXED)	B21	GND (FIXED)	A76	LVDS_A2-	B76	LVDS_B2-
A22	SATA2_TX+ (*)	B22	SATA3_TX+ (*)	A77	LVDS_VDD_EN	B77	LVDS_B3+
A23	SATA2_TX- (*)	B23	SATA3_TX- (*)	A78	LVDS_A3+	B78	LVDS_B3-
A24	SUS_S5#	B24	PWR_OK	A79	LVDS_A3-	B79	LVDS_BKLT_EN
A25	SATA2_RX+ (*)	B25	SATA3_RX+ (*)	A80	GND (FIXED)	B80	GND (FIXED)
A26	SATA2_RX- (*)	B26	SATA3_RX- (*)	A81	LVDS_A_CK+	B81	LVDS_B_CK+
A27	BATLOW#	B27	WDT	A82	LVDS_A_CK-	B82	LVDS_B_CK-
A28	(S)ATA_ACT#	B28	AC/HDA_SDIN2 (*)	A83	LVDS_I2C_CK	B83	LVDS_BKLT_CTRL
A29	AC/HDA_SYNC	B29	AC/HDA_SDIN1	A84	LVDS_I2C_DAT	B84	VCC_5V_SBY
A30	AC/HDA_RST#	B30	AC/HDA_SDIN0	A85	GPI3	B85	VCC_5V_SBY

Pin	Row A	Pin	Row B	Pin	Row A	Pin	Row B
A31	GND (FIXED)	B31	GND (FIXED)	A86	RSVD	B86	VCC_5V_SBY
A32	AC/HDA_BITCLK	B32	SPKR	A87	RSVD	B87	VCC_5V_SBY
A33	AC/HDA_SDOOUT	B33	I2C_CK	A88	PCIE0_CK_REF+	B88	BIOS_DIS1#
A34	BIOS_DIS0#	B34	I2C_DAT	A89	PCIE0_CK_REF-	B89	VGA_RED (*)
A35	THRMTRIP#	B35	THRM#	A90	GND (FIXED)	B90	GND (FIXED)
A36	USB6-	B36	USB7-	A91	SPI_POWER	B91	VGA_GRN (*)
A37	USB6+	B37	USB7+	A92	SPI_MISO	B92	VGA_BLU (*)
A38	USB_6_7_OC#	B38	USB_4_5_OC#	A93	GPO0	B93	VGA_HSYNC (*)
A39	USB4-	B39	USB5-	A94	SPI_CLK	B94	VGA_VSYNC (*)
A40	USB4+	B40	USB5+	A95	SPI_MOSI	B95	VGA_I2C_CK (*)
A41	GND (FIXED)	B41	GND (FIXED)	A96	TPM_PP	B96	VGA_I2C_DAT (*)
A42	USB2-	B42	USB3-	A97	TYPE10#	B97	SPI_CS#
A43	USB2+	B43	USB3+	A98	SER0_TX	B98	RSVD
A44	USB_2_3_OC#	B44	USB_0_1_OC#	A99	SER0_RX	B99	RSVD
A45	USB0-	B45	USB1-	A100	GND (FIXED)	B100	GND (FIXED)
A46	USB0+	B46	USB1+	A101	SER1_TX	B101	FAN_PWMOUT
A47	VCC_RTC	B47	EXCD1_PERST#	A102	SER1_RX	B102	FAN_TACHIN
A48	EXCD0_PERST#	B48	EXCD1_CPPE#	A103	LID#	B103	SLEEP#
A49	EXCD0_CPPE#	B49	SYS_RESET#	A104	VCC_12V	B104	VCC_12V
A50	LPC_SERIRQ	B50	CB_RESET#	A105	VCC_12V	B105	VCC_12V
A51	GND (FIXED)	B51	GND (FIXED)	A106	VCC_12V	B106	VCC_12V
A52	PCIE_TX5+ (*)	B52	PCIE_RX5+ (*)	A107	VCC_12V	B107	VCC_12V
A53	PCIE_TX5- (*)	B53	PCIE_RX5- (*)	A108	VCC_12V	B108	VCC_12V
A54	GPIO	B54	GPO1	A109	VCC_12V	B109	VCC_12V
A55	PCIE_TX4+	B55	PCIE_RX4+	A110	GND (FIXED)	B110	GND (FIXED)

 **Note**

The signals marked with an asterisk symbol (*) are not supported on the conga TCA4.

Table 12 Connector C-D Pinout

Pin	Row C	Pin	Row D	Pin	Row C	Pin	Row D
C1	GND (FIXED)	D1	GND (FIXED)	C56	PEG_RX1- (*)	D56	PEG_TX1- (*)
C2	GND	D2	GND	C57	TYPE1#	D57	TYPE2#
C3	USB_SSRX0-	D3	USB_SSTX0-	C58	PEG_RX2+ (*)	D58	PEG_TX2+ (*)
C4	USB_SSRX0+	D4	USB_SSTX0+	C59	PEG_RX2- (*)	D59	PEG_TX2- (*)
C5	GND	D5	GND	C60	GND (FIXED)	D60	GND (FIXED)
C6	USB_SSRX1-	D6	USB_SSTX1-	C61	PEG_RX3+ (*)	D61	PEG_TX3+ (*)
C7	USB_SSRX1+	D7	USB_SSTX1+	C62	PEG_RX3- (*)	D62	PEG_TX3- (*)
C8	GND	D8	GND	C63	RSVD	D63	RSVD (*)
C9	USB_SSRX2-	D9	USB_SSTX2-	C64	RSVD	D64	RSVD (*)
C10	USB_SSRX2+	D10	USB_SSTX2+	C65	PEG_RX4+ (*)	D65	PEG_TX4+ (*)
C11	GND (FIXED)	D11	GND (FIXED)	C66	PEG_RX4- (*)	D66	PEG_TX4- (*)
C12	USB_SSRX3-	D12	USB_SSTX3-	C67	RSVD	D67	GND
C13	USB_SSRX3+	D13	USB_SSTX3+	C68	PEG_RX5+ (*)	D68	PEG_TX5+ (*)
C14	GND	D14	GND	C69	PEG_RX5- (*)	D69	PEG_TX5- (*)
C15	DDI1_PAIR6+ (*)	D15	DDI1_CTRLCLK_AUX+	C70	GND (FIXED)	D70	GND (FIXED)
C16	DDI1_PAIR6- (*)	D16	DDI1_CTRLDATA_AUX-	C71	PEG_RX6+ (*)	D71	PEG_TX6+ (*)
C17	RSVD	D17	RSVD	C72	PEG_RX6- (*)	D72	PEG_TX6- (*)
C18	RSVD	D18	RSVD	C73	GND	D73	GND
C19	PCIE_RX6+ (*)	D19	PCIE_TX6+ (*)	C74	PEG_RX7+ (*)	D74	PEG_TX7+ (*)
C20	PCIE_RX6- (*)	D20	PCIE_TX6- (*)	C75	PEG_RX7- (*)	D75	PEG_TX7- (*)
C21	GND (FIXED)	D21	GND (FIXED)	C76	GND	D76	GND
C22	PCIE_RX7+ (*)	D22	PCIE_TX7+ (*)	C77	RSVD	D77	RSVD
C23	PCIE_RX7- (*)	D23	PCIE_TX7- (*)	C78	PEG_RX8+ (*)	D78	PEG_TX8+ (*)
C24	DDI1_HPD	D24	RSVD	C79	PEG_RX8- (*)	D79	PEG_TX8- (*)
C25	DDI1_PAIR4+ (*)	D25	RSVD	C80	GND (FIXED)	D80	GND (FIXED)
C26	DDI1_PAIR4- (*)	D26	DDI1_PAIR0+	C81	PEG_RX9+ (*)	D81	PEG_TX9+ (*)
C27	RSVD	D27	DDI1_PAIR0-	C82	PEG_RX9- (*)	D82	PEG_TX9- (*)
C28	RSVD	D28	RSVD	C83	RSVD	D83	RSVD
C29	DDI1_PAIR5+ (*)	D29	DDI1_PAIR1+	C84	GND	D84	GND
C30	DDI1_PAIR5- (*)	D30	DDI1_PAIR1-	C85	PEG_RX10+ (*)	D85	PEG_TX10+ (*)
C31	GND (FIXED)	D31	GND (FIXED)	C86	PEG_RX10- (*)	D86	PEG_TX10- (*)
C32	DDI2_CTRLCLK_AUX+	D32	DDI1_PAIR2+	C87	GND	D87	GND

Pin	Row C	Pin	Row D	Pin	Row C	Pin	Row D
C33	DDI2_CTRLDATA_AUX-	D33	DDI1_PAIR2-	C88	PEG_RX11+ (*)	D88	PEG_TX11+ (*)
C34	DDI2_DDC_AUX_SEL	D34	DDI1_DDC_AUX_SEL	C89	PEG_RX11- (*)	D89	PEG_TX11- (*)
C35	RSVD	D35	RSVD	C90	GND (FIXED)	D90	GND (FIXED)
C36	DDI3_CTRLCLK_AUX+ (*)	D36	DDI1_PAIR3+	C91	PEG_RX12+ (*)	D91	PEG_TX12+ (*)
C37	DDI3_CTRLDATA_AUX- (*)	D37	DDI1_PAIR3-	C92	PEG_RX12- (*)	D92	PEG_TX12- (*)
C38	DDI3_DDC_AUX_SEL (*)	D38	RSVD	C93	GND	D93	GND
C39	DDI3_PAIR0+	D39	DDI2_PAIR0+	C94	PEG_RX13+ (*)	D94	PEG_TX13+ (*)
C40	DDI3_PAIR0-	D40	DDI2_PAIR0-	C95	PEG_RX13- (*)	D95	PEG_TX13- (*)
C41	GND (FIXED)	D41	GND (FIXED)	C96	GND	D96	GND
C42	DDI3_PAIR1+	D42	DDI2_PAIR1+	C97	RVSD	D97	RSVD
C43	DDI3_PAIR1-	D43	DDI2_PAIR1-	C98	PEG_RX14+ (*)	D98	PEG_TX14+ (*)
C44	DDI3_HPD	D44	DDI2_HPD	C99	PEG_RX14- (*)	D99	PEG_TX14- (*)
C45	RSVD	D45	RSVD	C100	GND (FIXED)	D100	GND (FIXED)
C46	DDI3_PAIR2+	D46	DDI2_PAIR2+	C101	PEG_RX15+ (*)	D101	PEG_TX15+ (*)
C47	DDI3_PAIR2-	D47	DDI2_PAIR2-	C102	PEG_RX15- (*)	D102	PEG_TX15- (*)
C48	RSVD	D48	RSVD	C103	GND	D103	GND
C49	DDI3_PAIR3+	D49	DDI2_PAIR3+	C104	VCC_12V	D104	VCC_12V
C50	DDI3_PAIR3-	D50	DDI2_PAIR3-	C105	VCC_12V	D105	VCC_12V
C51	GND (FIXED)	D51	GND (FIXED)	C106	VCC_12V	D106	VCC_12V
C52	PEG_RX0+ (*)	D52	PEG_TX0+ (*)	C107	VCC_12V	D107	VCC_12V
C53	PEG_RX0- (*)	D53	PEG_TX0- (*)	C108	VCC_12V	D108	VCC_12V
C54	TYPE0#	D54	PEG_LANE_RV#	C109	VCC_12V	D109	VCC_12V
C55	PEG_RX1+ (*)	D55	PEG_TX1+ (*)	C110	GND (FIXED)	D110	GND (FIXED)



The signals marked with an asterisk symbol (*) are not supported on the conga-TCA4.

Table 13 PCI Express Signal Descriptions (general purpose)

Signal	Pin #	Description	I/O	PU/PD	Comment
PCIE_RX0+ PCIE_RX0-	B68 B69	PCI Express channel 0, Receive Input differential pair.	I PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_TX0+ PCIE_TX0-	A68 A69	PCI Express channel 0, Transmit Output differential pair.	O PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_RX1+ PCIE_RX1-	B64 B65	PCI Express channel 1, Receive Input differential pair.	I PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_TX1+ PCIE_TX1-	A64 A65	PCI Express channel 1, Transmit Output differential pair.	O PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_RX2+ PCIE_RX2-	B61 B62	PCI Express channel 2, Receive Input differential pair.	I PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_TX2+ PCIE_TX2-	A61 A62	PCI Express channel 2, Transmit Output differential pair.	O PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_RX3+ PCIE_RX3-	B58 B59	PCI Express channel 3, Receive Input differential pair.	I PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_TX3+ PCIE_TX3-	A58 A59	PCI Express channel 3, Transmit Output differential pair.	O PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_RX4+ PCIE_RX4-	B55 B56	PCI Express channel 4, Receive Input differential pair.	I PCIE		Supports PCI Express Base Specification, Revision 2.0
PCIE_TX4+ PCIE_TX4-	A55 A56	PCI Express channel 4, Transmit Output differential pair.	O PCIE		Supports PCI Express Base Specification, Revision 2.0.
PCIE_RX5+ PCIE_RX5-	B52 B53	PCI Express channel 5, Receive Input differential pair.	I PCIE		Not supported
PCIE_TX5+ PCIE_TX5-	A52 A53	PCI Express channel 5, Transmit Output differential pair.	O PCIE		Not supported
PCIE_RX6+ PCIE_RX6-	C19 C20	PCI Express channel 6, Receive Input differential pair.	I PCIE		Not supported.
PCIE_TX6+ PCIE_TX6-	D19 D20	PCI Express channel 6, Transmit Output differential pair.	O PCIE		Not supported.
PCIE_RX7+ PCIE_RX7-	C22 C23	PCI Express channel 7, Receive Input differential pair.	I PCIE		Not supported.
PCIE_TX7+ PCIE_TX7-	D22 D23	PCI Express channel 7, Transmit Output differential pair.	O PCIE		Not supported.
PCIE_CLK_ REF+ PCIE_CLK_REF-	A88 A89	PCI Express Reference Clock output for all PCI Express and PCI Express Graphics Lanes.	O PCIE		A PCI Express compliant clock buffer chip must be used on the carrier board if more than one PCI Express device is designed in.

Table 14 PCI Express Signal Descriptions (x16 Graphics)

Signal	Pin #	Description	I/O	PU/PD	Comment
PEG_RX0+	C52	PCI Express Graphics Receive Input differential pairs. <i>Note: Can also be used as PCI Express Receive Input differential pairs 16 through 31 known as PCIE_RX[16-31] + and -.</i>	I PCIE		Not supported.
PEG_RX0-	C53				
PEG_RX1+	C55				
PEG_RX1-	C56				
PEG_RX2+	C58				
PEG_RX2-	C59				
PEG_RX3+	C61				
PEG_RX3-	C62				
PEG_RX4+	C65				
PEG_RX4-	C66				
PEG_RX5+	C68				
PEG_RX5-	C69				
PEG_RX6+	C71				
PEG_RX6-	C72				
PEG_RX7+	C74				
PEG_RX7-	C75				
PEG_RX8+	C78				
PEG_RX8-	C79				
PEG_RX9+	C81				
PEG_RX9-	C82				
PEG_RX10+	C85				
PEG_RX10-	C86				
PEG_RX11+	C88				
PEG_RX11-	C89				
PEG_RX12+	C91				
PEG_RX12-	C92				
PEG_RX13+	C94				
PEG_RX13-	C95				
PEG_RX14+	C98				
PEG_RX14-	C99				
PEG_RX15+	C101				
PEG_RX15-	C102				

Signal	Pin #	Description	I/O	PU/PD	Comment
PEG_TX0+	D52	PCI Express Graphics Transmit Output differential pairs. <i>Note: Can also be used as PCI Express Transmit Output differential pairs 16 through 31 known as PCIE_TX[16-31] + and -.</i>	O PCIE		Not supported.
PEG_TX0-	D53				
PEG_TX1+	D55				
PEG_TX1-	D56				
PEG_TX2+	D58				
PEG_TX2-	D59				
PEG_TX3+	D61				
PEG_TX3-	D62				
PEG_TX4+	D65				
PEG_TX4-	D66				
PEG_TX5+	D68				
PEG_TX5-	D69				
PEG_TX6+	D71				
PEG_TX6-	D72				
PEG_TX7+	D74				
PEG_TX7-	D75				
PEG_TX8+	D78				
PEG_TX8-	D79				
PEG_TX9+	D81				
PEG_TX9-	D82				
PEG_TX10+	D85				
PEG_TX10-	D86				
PEG_TX11+	D88				
PEG_TX11-	D89				
PEG_TX12+	D91				
PEG_TX12-	D92				
PEG_TX13+	D94				
PEG_TX13-	D95				
PEG_TX14+	D98				
PEG_TX14-	D99				
PEG_TX15+	D101				
PEG_TX15-	D102				
PEG_LANE_RV#	D54	PCI Express Graphics lane reversal input strap. Pull low on the carrier board to reverse lane order.	I		Not supported.

 **Note**

PCI Express Graphics is not supported on conga-TCA4 modules

Table 15 DDI Signal Description

Signal	Pin #	Description	I/O	PU/PD	Comment
DDI1_PAIR0+ DDI1_PAIR0-	D26 D27	Multiplexed with SDVO1_RED+, DP1_LANE0+ and TMDS1_DATA2+. Multiplexed with SDVO1_RED-, DP1_LANE0- and TMDS1_DATA2-.	O PCIE		Only TMDS/DP option, no SDVO.
DDI1_PAIR1+ DDI1_PAIR1-	D29 D30	Multiplexed with SDVO1_GRN+, DP1_LANE1+ and TMDS1_DATA1+. Multiplexed with SDVO1_GRN-, DP1_LANE1- and TMDS1_DATA1-.	O PCIE		Only TMDS/DP option, no SDVO.
DDI1_PAIR2+ DDI1_PAIR2-	D32 D33	Multiplexed with SDVO1_BLU+, DP1_LANE2+ and TMDS1_DATA0+. Multiplexed with SDVO1_BLU-, DP1_LANE2- and TMDS1_DATA0-.	O PCIE		Only TMDS/DP option, no SDVO.
DDI1_PAIR3+ DDI1_PAIR3-	D36 D37	Multiplexed with SDVO1_CK+, DP1_LANE3+ and TMDS1_CLK+. Multiplexed with SDVO1_CK-, DP1_LANE3- and TMDS1_CLK-.	O PCIE		Only TMDS/DP option, no SDVO.
DDI1_PAIR4+ DDI1_PAIR4-	C25 C26	Multiplexed with SDVO1_INT+. Multiplexed with SDVO1_INT-.			Not supported due to missing SDVO support.
DDI1_PAIR5+ DDI1_PAIR5-	C29 C30	Multiplexed with SDVO1_TVCLKIN+. Multiplexed with SDVO1_TVCLKIN-.			Not supported due to missing SDVO support.
DDI1_PAIR6+ DDI1_PAIR6-	C15 C16	Multiplexed with SDVO1_FLDSTALL+. Multiplexed with SDVO1_FLDSTALL-.			Not supported due to missing SDVO support.
DDI1_HPD	C24	Multiplexed with DP1_HPD and HDMI1_HPD.	I 3.3V	PD 100k	
DDI1_CTRLCLK_AUX+	D15	Multiplexed with SDVO1_CTRLCLK, DP1_AUX+ and HDMI1_CTRLCLK. DP AUX+ function if DDI1_DDC_AUX_SEL is no connect. HDMI/DVI I2C CTRLCLK if DDI1_DDC_AUX_SEL is pulled high	I/O PCIE I/O OD 3.3V	PD100k @ DP mode, PU 2.49k 3.3V @ HDMI/DVI mode	
DDI1_CTRLDATA_AUX-	D16	Multiplexed with SDVO1_CTRLDATA, DP1_AUX- and HDMI1_CTRLDATA. DP AUX- function if DDI1_DDC_AUX_SEL is no connect. HDMI/DVI I2C CTRLDATA if DDI1_DDC_AUX_SEL is pulled high	I/O PCIE I/O OD 3.3V	PU 100k 3.3V@ DP mode, PU 2.49k 3.3V @ HDMI/DVI mode	
DDI1_DDC_AUX_SEL	D34	Selects the function of DDI1_CTRLCLK_AUX+ and DDI1_CTRLDATA_AUX-. This pin shall have a 1M pull-down to logic ground on the module. If this input is floating, the AUX pair is used for the DP AUX+/- signals. If pulled-high, the AUX pair contains the CTRLCLK and CTRLDATA signals.	I 3.3V	PD 1M	
DDI2_PAIR0+ DDI2_PAIR0-	D39 D40	Multiplexed with DP2_LANE0+ and TMDS2_DATA2+. Multiplexed with DP2_LANE0- and TMDS2_DATA2-.	O PCIE		
DDI2_PAIR1+ DDI2_PAIR1-	D42 D43	Multiplexed with DP2_LANE1+ and TMDS2_DATA1+. Multiplexed with DP2_LANE1- and TMDS2_DATA1-.	O PCIE		
DDI2_PAIR2+ DDI2_PAIR2-	D46 D47	Multiplexed with DP2_LANE2+ and TMDS2_DATA0+. Multiplexed with DP2_LANE2- and TMDS2_DATA0-.	O PCIE		
DDI2_PAIR3+ DDI2_PAIR3-	D49 D50	Multiplexed with DP2_LANE3+ and TMDS2_CLK+. Multiplexed with DP2_LANE3- and TMDS2_CLK-.	O PCIE		
DDI2_HPD	D44	Multiplexed with DP2_HPD and HDMI2_HPD.	I 3.3V	PD 100k	

Signal	Pin #	Description	I/O	PU/PD	Comment
DDI2_CTRLCLK_AUX+	C32	Multiplexed with DP2_AUX+ and HDMI2_CTRLCLK. DP AUX+ function if DDI2_DDC_AUX_SEL is no connect. HDMI/DVI I2C CTRLCLK if DDI2_DDC_AUX_SEL is pulled high	I/O PCIE I/O OD 3.3V	PD100k @ DP mode, PU 2.49k 3.3V @ HDMI/DVI mode	
DDI2_CTRLDATA_AUX-	C33	Multiplexed with DP2_AUX- and HDMI2_CTRLDATA. DP AUX- function if DDI2_DDC_AUX_SEL is no connect. HDMI/DVI I2C CTRLDATA if DDI2_DDC_AUX_SEL is pulled high.	I/O PCIE I/O OD 3.3V	PU 100k 3.3V@ DP mode, PU 2.49k 3.3V @ HDMI/DVI mode	
DDI2_DDC_AUX_SEL	C34	Selects the function of DDI2_CTRLCLK_AUX+ and DDI2_CTRLDATA_AUX-. This pin shall have a 1M pull-down to logic ground on the module. If this input is floating, the AUX pair is used for the DP AUX+/- signals. If pulled-high, the AUX pair contains the CTRLCLK and CTRLDATA signals	I 3.3V	PD 1M	
DDI3_PAIR0+ DDI3_PAIR0-	C39 C40	Multiplexed with DP3_LANE0+ and TMDS3_DATA2+. Multiplexed with DP3_LANE0- and TMDS3_DATA2-.	O PCIE		Optional DDI3 or LVDS. Only DP supported. TMDS not supported
DDI3_PAIR1+ DDI3_PAIR1-	C42 C43	Multiplexed with DP3_LANE1+ and TMDS3_DATA1+. Multiplexed with DP3_LANE1- and TMDS3_DATA1-.	O PCIE		Optional DDI3 or LVDS. Only DP supported. TMDS not supported
DDI3_PAIR2+ DDI3_PAIR2-	C46 C47	Multiplexed with DP3_LANE2+ and TMDS3_DATA0+. Multiplexed with DP3_LANE2- and TMDS3_DATA0-.	O PCIE		Optional DDI3 or LVDS. Only DP supported. TMDS not supported
DDI3_PAIR3+ DDI3_PAIR3-	C49 C50	Multiplexed with DP3_LANE3+ and TMDS3_CLK+. Multiplexed with DP3_LANE3- and TMDS3_CLK-.	O PCIE		Optional DDI3 or LVDS. Only DP supported. TMDS not supported
DDI3_HPD	C44	Multiplexed with DP3_HPD and HDMI3_HPD.	I 3.3V	PD100k	Optional DDI3 or LVDS. Only DP supported. TMDS not supported
DDI3_CTRLCLK_AUX+	C36	DP3_AUX+	I/O PCIE	PD100k	Optional DDI3 or LVDS. Only DP supported. TMDS not supported
DDI3_CTRLDATA_AUX-	C37	DP3_AUX-	I/O PCIE	PU100k 3.3V	Optional DDI3 or LVDS. Only DP supported. TMDS not supported
DDI3_DDC_AUX_SEL	C38	Selects the function of DDI3_CTRLCLK_AUX+ and DDI3_CTRLDATA_AUX-. This pin shall have a 1M pull-down to logic ground on the module. If this input is floating, the AUX pair is used for the DP AUX+/- signals. If pulled-high, the AUX pair contains the CTRLCLK and CTRLDATA signals	I 3.3V		Optional DDI3 or LVDS. Only DP supported. TMDS not supported

 **Note**

The third DDI channel (DDI3) is only available if LVDS is not used. Refer to the TMDS and DisplayPort signal description tables for information about the signals routed to the DDI interface of the COM Express connector.

Table 16 TMDS Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
TMDS1_CLK + TMDS1_CLK -	D36 D37	TMDS Clock output differential pair. Multiplexed with DDI1_PAIR3+ and DDI1_PAIR3-.	O PCIE		
TMDS1_DATA0+ TMDS1_DATA0-	D32 D33	TMDS differential pair. Multiplexed with DDI1_PAIR2+ and DDI1_PAIR2-.	O PCIE		
TMDS1_DATA1+ TMDS1_DATA1-	D29 D30	TMDS differential pair. Multiplexed with DDI1_PAIR1+ and DDI1_PAIR1-.	O PCIE		
TMDS1_DATA2+ TMDS1_DATA2-	D26 D27	TMDS differential pair. Multiplexed with DDI1_PAIR0+ and DDI1_PAIR0-.	O PCIE		
HDMI1_HPD	C24	TMDS Hot-plug detect. Multiplexed with DDI1_HPD.	I PCIE	PD 1M	
HDMI1_CTRLCLK	D15	TMDS I ² C Control Clock Multiplexed with DDI1_CTRLCLK_AUX+	I/O OD 3.3V	PU 2.49k 3.3V	
HDMI1_CTRLDATA	D16	TMDS I ² C Control Data Multiplexed with DDI1_CTRLDATA_AUX-	I/O OD 3.3V	PU 2.49k 3.3V	
TMDS2_CLK + TMDS2_CLK -	D49 D50	TMDS Clock output differential pair.. Multiplexed with DDI2_PAIR3+ and DDI2_PAIR3-.	O PCIE		
TMDS2_DATA0+ TMDS2_DATA0-	D46 D47	TMDS differential pair. Multiplexed with DDI2_PAIR2+ and DDI2_PAIR2-.	O PCIE		
TMDS2_DATA1+ TMDS2_DATA1-	D42 D43	TMDS differential pair. Multiplexed with DDI2_PAIR1+ and DDI2_PAIR1-.	O PCIE		
TMDS2_DATA2+ TMDS2_DATA2-	D39 D40	TMDS differential pair. Multiplexed with DDI2_PAIR0+ and DDI2_PAIR0-.	O PCIE		
HDMI2_HPD	D44	TMDS Hot-plug detect. Multiplexed with DDI2_HPD	I PCIE	PD 100k	
HDMI2_CTRLCLK	C32	TMDS I ² C Control Clock Multiplexed with DDI2_CTRLCLK_AUX+	I/O OD 3.3V	PU 2.49k 3.3V	
HDMI2_CTRLDATA	C33	TMDS I ² C Control Data Multiplexed with DDI2_CTRLDATA_AUX-	I/O OD 3.3V	PU 2.49k 3.3V	
TMDS3_CLK + TMDS3_CLK -	C49 C50	TMDS Clock output differential pair.. Multiplexed with DDI3_PAIR3+ and DDI3_PAIR3-.	O PCIE		Not supported
TMDS3_DATA0+ TMDS3_DATA0-	C46 C47	TMDS differential pair. Multiplexed with DDI3_PAIR2+ and DDI3_PAIR2-.	O PCIE		Not supported
TMDS3_DATA1+ TMDS3_DATA1-	C42 C43	TMDS differential pair. Multiplexed with DDI3_PAIR1+ and DDI3_PAIR1-.	O PCIE		Not supported
TMDS3_DATA2+ TMDS3_DATA2-	C39 C40	TMDS differential pair. Multiplexed with DDI3_PAIR0+ and DDI3_PAIR0-.	O PCIE		Not supported

Signal	Pin #	Description	I/O	PU/PD	Comment
HDMI3_HPD	C44	TMDS Hot-plug detect. Multiplexed with DDI3_HPD.	I PCIE	PD100k	Not supported
HDMI3_CTRLCLK	C36	TMDS I ² C Control Clock Multiplexed with DDI3_CTRLCLK_AUX+	I/O OD 3.3V	PD100k	Not supported
HDMI3_CTRLDATA	C37	TMDS I ² C Control Data Multiplexed with DDI3_CTRLDATA_AUX-	I/O OD 3.3V	PU 100k	Not supported



- Note**
1. The second TMDS interface is only available if LVDS is not used.
 2. The conga-TCA4 does not natively support TMDS. A DP++ to TMDS converter (e.g. PTN3360D) needs to be implemented.

Table 17 DisplayPort (DP) Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
DP1_LANE3+ DP1_LANE3-	D36 D37	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI1_PAIR3+ and DDI1_PAIR3-.	O PCIE		
DP1_LANE2+ DP1_LANE2-	D32 D33	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI1_PAIR2+ and DDI1_PAIR2-.	O PCIE		
DP1_LANE1+ DP1_LANE1-	D29 D30	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI1_PAIR1+ and DDI1_PAIR1-.	O PCIE		
DP1_LANE0+ DP1_LANE0-	D26 D27	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI1_PAIR0+ and DDI1_PAIR0-.	O PCIE		
DP1_HPD	C24	Detection of Hot Plug / Unplug and notification of the link layer. Multiplexed with DDI1_HPD.	I 3.3V	PD 1M	
DP1_AUX+	D15	Half-duplex bi-directional AUX channel for services such as link configuration or maintenance and EDID access.	I/O PCIE	PD 100k	
DP1_AUX-	D16	Half-duplex bi-directional AUX channel for services such as link configuration or maintenance and EDID access.	I/O PCIE	PU 100k 3.3V	
DP2_LANE3+ DP2_LANE3-	D49 D50	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI2_PAIR3+ and DDI2_PAIR3-	O PCIE		
DP2_LANE2+ DP2_LANE2-	D46 D47	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI2_PAIR2+ and DDI2_PAIR2-	O PCIE		
DP2_LANE1+ DP2_LANE1-	D42 D43	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI2_PAIR1+ and DDI2_PAIR1-	O PCIE		

Signal	Pin #	Description	I/O	PU/PD	Comment
DP2_LANE0+ DP2_LANE0-	D39 D40	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI2_PAIR0+ and DDI1_PAIR0-	O PCIE		
DP2_HPD	D44	Detection of Hot Plug / Unplug and notification of the link layer. Multiplexed with DDI2_HPD.	I 3.3V	PD 100k	
DP2_AUX+	C32	Half-duplex bi-directional AUX channel for services such as link configuration or maintenance and EDID access.	I/O PCIE	PD 100k	
DP2_AUX-	C33	Half-duplex bi-directional AUX channel for services such as link configuration or maintenance and EDID access.	I/O PCIE	PU 100k 3.3V	
DP3_LANE3+ DP3_LANE3-	C49 C50	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI3_PAIR3+ and DDI3_PAIR3-.	O PCIE		
DP3_LANE2+ DP3_LANE2-	C46 C47	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI3_PAIR2+ and DDI3_PAIR2-.	O PCIE		
DP3_LANE1+ DP3_LANE1-	C42 C43	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI3_PAIR1+ and DDI3_PAIR1-.	O PCIE		
DP3_LANE0+ DP3_LANE0-	C39 C40	Uni-directional main link for the transport of isochronous streams and secondary data. Multiplexed with DDI3_PAIR0+ and DDI3_PAIR0-.	O PCIE		
DP3_HPD	C44	Detection of Hot Plug / Unplug and notification of the link layer. Multiplexed with DDI3_HPD.	I 3.3V	PD 100k	
DP3_AUX+	C36	Half-duplex bi-directional AUX channel for services such as link configuration or maintenance and EDID access.	I/O PCIE	PD 100k	
DP3_AUX-	C37	Half-duplex bi-directional AUX channel for services such as link configuration or maintenance and EDID access.	I/O PCIE	PU 100k	



Note

The third DP interface is only available if LVDS is not used.

Table 18 CRT Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
VGA_RED	B89	Red for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O Analog		Not supported
VGA_GRN	B91	Green for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O Analog		Not supported
VGA_BLU	B92	Blue for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O Analog		Not supported
VGA_HSYNC	B93	Horizontal sync output to VGA monitor	O 3.3V		Not supported
VGA_VSYNC	B94	Vertical sync output to VGA monitor	O 3.3V		Not supported
VGA_I2C_CK	B95	DDC clock line (I ² C port dedicated to identify VGA monitor capabilities)	I/O OD 5V		Not supported
VGA_I2C_DAT	B96	DDC data line.	I/O OD 5V		Not supported

Table 19 LVDS Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
LVDS_A0+ LVDS_A0- LVDS_A1+ LVDS_A1- LVDS_A2+ LVDS_A2- LVDS_A3+ LVDS_A3-	A71 A72 A73 A74 A75 A76 A78 A79	LVDS Channel A differential pairs	O LVDS		
LVDS_A_CK+ LVDS_A_CK-	A81 A82	LVDS Channel A differential clock	O LVDS		
LVDS_B0+ LVDS_B0- LVDS_B1+ LVDS_B1- LVDS_B2+ LVDS_B2- LVDS_B3+ LVDS_B3-	B71 B72 B73 B74 B75 B76 B77 B78	LVDS Channel B differential pairs	O LVDS		
LVDS_B_CK+ LVDS_B_CK-	B81 B82	LVDS Channel B differential clock	O LVDS		
LVDS_VDD_EN	A77	LVDS panel power enable	O 3.3V	PD 10k	
LVDS_BKLT_EN	B79	LVDS panel backlight enable	O 3.3V	PD 10k	
LVDS_BKLT_CTRL	B83	LVDS panel backlight brightness control	O 3.3V	PD 10k	
LVDS_I2C_CK	A83	DDC lines used for flat panel detection and control.	O 3.3V	PU 2k49	
LVDS_I2C_DAT	A84	DDC lines used for flat panel detection and control.	I/O 3.3V	PU 2k49	

 **Note**

The LVDS signals are available only if the optional DDI (DDI3) is not used.

Table 20 Serial ATA Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
SATA0_RX+ SATA0_RX-	A19 A20	Serial ATA channel 0, Receive Input differential pair.	I SATA		Supports Serial ATA 3 specification, up to 6 Gb/s
SATA0_TX+ SATA0_TX-	A16 A17	Serial ATA channel 0, Transmit Output differential pair.	O SATA		Supports Serial ATA 3 specification, up to 6 Gb/s
SATA1_RX+ SATA1_RX-	B19 B20	Serial ATA channel 1, Receive Input differential pair.	I SATA		Supports Serial ATA 3 specification, up to 6 Gb/s
SATA1_TX+ SATA1_TX-	B16 B17	Serial ATA channel 1, Transmit Output differential pair.	O SATA		Supports Serial ATA 3 specification, up to 6 Gb/s
SATA2_RX+ SATA2_RX-	A25 A26	Serial ATA channel 2, Receive Input differential pair.	I SATA		Not supported
SATA2_TX+ SATA2_TX-	A22 A23	Serial ATA channel 2, Transmit Output differential pair.	O SATA		Not supported
SATA3_RX+ SATA3_RX-	B25 B26	Serial ATA channel 3, Receive Input differential pair.	I SATA		Not supported
SATA3_TX+ SATA3_TX-	B22 B23	Serial ATA channel 3, Transmit Output differential pair.	O SATA		Not supported
(S)ATA_ACT#	A28	ATA (parallel and serial) or SAS activity indicator, active low.	I/O 3.3v		

Table 21 USB 2.0 Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
USB0+	A46	USB Port 0, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB0-	A45	USB Port 0, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB1+	B46	USB Port 1, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB1-	B45	USB Port 1, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB2+	A43	USB Port 2, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB2-	A42	USB Port 2, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB3+	B43	USB Port 3, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB3-	B42	USB Port 3, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB4+	A40	USB Port 4, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB4-	A39	USB Port 4, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB5+	B40	USB Port 5, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1

Signal	Pin #	Description	I/O	PU/PD	Comment
USB5-	B39	USB Port 5, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB6+	A37	USB Port 6, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB6-	A36	USB Port 6, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB7+	B37	USB Port 7, data + or D+	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB7-	B36	USB Port 7, data - or D-	I/O		USB 2.0 compliant. Backwards compatible to USB 1.1
USB_0_1_OC#	B44	USB over-current sense, USB ports 0 and 1. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low.	I 3.3VSB	PU 10k 3.3VSB	Do not pull this line high on the carrier board.
USB_2_3_OC#	A44	USB over-current sense, USB ports 2 and 3. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low. .	I 3.3VSB	PU 10k 3.3VSB	Do not pull this line high on the carrier board.
USB_4_5_OC#	B38	USB over-current sense, USB ports 4 and 5. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low.	I 3.3VSB	PU 10k 3.3VSB	Do not pull this line high on the carrier board.
USB_6_7_OC#	A38	USB over-current sense, USB ports 6 and 7. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low.	I 3.3VSB	PU 10k 3.3VSB	Do not pull this line high on the carrier board..

Table 22 USB 3.0 Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
USB_SSRX0+	C4	Additional receive signal differential pairs for the Superspeed USB data path	I		
USB_SSRX0-	C3		I		
USB_SSTX0+	D4	Additional transmit signal differential pairs for the Superspeed USB data path	O		
USB_SSTX0-	D3		O		
USB_SSRX1+	C7	Additional receive signal differential pairs for the Superspeed USB data path	I		
USB_SSRX1-	C6		I		
USB_SSTX1+	D7	Additional transmit signal differential pairs for the Superspeed USB data path	O		
USB_SSTX1-	D6		O		

Signal	Pin #	Description	I/O	PU/PD	Comment
USB_SSRX2+	C10	Additional receive signal differential pairs for the Superspeed USB data path	I		
USB_SSRX2-	C9		I		
USB_SSTX2+	D10	Additional transmit signal differential pairs for the Superspeed USB data path	O		
USB_SSTX2-	D9		O		
USB_SSRX3+	C13	Additional receive signal differential pairs for the Superspeed USB data path	I		
USB_SSRX3-	C12		I		
USB_SSTX3+	D13	Additional transmit signal differential pairs for the Superspeed USB data path	O		
USB_SSTX3-	D12		O		

Table 23 Gigabit Ethernet Signal Descriptions

Gigabit Ethernet	Pin #	Description	I/O	PU/PD	Comment				
GBE0_MDI0+	A13	Gigabit Ethernet Controller 0: Media Dependent Interface Differential Pairs 0, 1, 2, 3. The MDI can operate in 1000, 100, and 10 Mb/s modes. Some pairs are unused in some modes according to the following:	I/O Analog		Twisted pair signals for external transformer.				
GBE0_MDI0-	A12								
GBE0_MDI1+	A10								
GBE0_MDI1-	A9						1000	100	10
GBE0_MDI2+	A7					MDI[0]+/-	B1_DA+/-	TX+/-	TX+/-
GBE0_MDI2-	A6					MDI[1]+/-	B1_DB+/-	RX+/-	RX+/-
GBE0_MDI3+	A3					MDI[2]+/-	B1_DC+/-		
GBE0_MDI3-	A2	MDI[3]+/-	B1_DD+/-						
GBE0_ACT#	B2	Gigabit Ethernet Controller 0 activity indicator, active low.	O 3.3VSB						
GBE0_LINK#	A8	Gigabit Ethernet Controller 0 link indicator, active low.	O 3.3VSB						
GBE0_LINK100#	A4	Gigabit Ethernet Controller 0 100 Mb/s link indicator, active low.	O 3.3VSB						
GBE0_LINK1000#	A5	Gigabit Ethernet Controller 0 1000 Mb/s link indicator, active low.	O 3.3VSB						
GBE0_CTREF	A14	Reference voltage for Carrier Board Ethernet channel 0 magnetics center tap. The reference voltage is determined by the requirements of the module PHY and may be as low as 0 V and as high as 3.3 V. The reference voltage output shall be current limited on the module. In the case in which the reference is shorted to ground, the current shall be limited to 250 mA or less.			Not connected				

Table 24 Intel® High Definition Audio Link Signals Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
AC/HDA_RST#	A30	Intel® High Definition Audio Reset: This signal is the master hardware reset to external codec(s).	O 3.3V		AC'97 codecs are not supported.
AC/HDA_SYNC	A29	Intel® High Definition Audio Sync: This signal is a 48 kHz fixed rate sample sync to the codec(s). It is also used to encode the stream number.	O 3.3V		AC'97 codecs are not supported.
AC/HDA_BITCLK	A32	Intel® High Definition Audio Bit Clock Output: This signal is a 24.000 MHz serial data clock generated by the Intel® High Definition Audio controller.	O 3.3V		AC'97 codecs are not supported.
AC/HDA_SDOUT	A33	Intel® High Definition Audio Serial Data Out: This signal is the serial TDM data output to the codec(s). This serial output is double-pumped for a bit rate of 48 Mb/s for Intel® High Definition Audio.	O 3.3V		AC'97 codecs are not supported.
AC/HDA_SDIN[1:0]	B29-B30	Intel® High Definition Audio Serial Data In [1:0]: These signals are serial TDM data inputs from the two codecs. The serial input is single-pumped for a bit rate of 24 Mb/s for Intel® High Definition Audio.	I 3.3V	100k PD	AC'97 codecs are not supported. AC/HDA_SDIN2 is not supported

Table 25 ExpressCard Support Pins Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
EXCD0_CPPE#	A49	ExpressCard 0 capable card request.	I 3.3V	PU 100k 3.3V	
EXCD0_PERST#	A48	ExpressCard 0 Reset	O 3.3V		
EXCD1_CPPE#	B48	ExpressCard 1 capable card request	I 3.3V	PU 100k 3.3V	
EXCD1_PERST#	B47	ExpressCard 1 Reset	O 3.3V		

Table 26 LPC Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
LPC_AD[0:3]	B4-B7	LPC multiplexed address, command and data bus	I/O 3.3V		
LPC_FRAME#	B3	LPC frame indicates the start of an LPC cycle	O 3.3V		
LPC_DRQ[0:1]#	B8-B9	LPC serial DMA request	I 3.3V		Not connected
LPC_SERIRQ	A50	LPC serial interrupt	I/O 3.3V		
LPC_CLK	B10	LPC clock output - 25 MHz nominal	O 3.3V		

Table 27 SPI BIOS Flash Interface Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
SPI_CS#	B97	Chip select for Carrier Board SPI BIOS Flash.	O 3.3VSB	PU 100k 3.3VSB	
SPI_MISO	A92	Data in to module from carrier board SPI BIOS flash.	I 3.3VSB		
SPI_MOSI	A95	Data out from module to carrier board SPI BIOS flash.	O 3.3VSB		
SPI_CLK	A94	Clock from module to carrier board SPI BIOS flash.	O 3.3VSB		
SPI_POWER	A91	Power source for carrier board SPI BIOS flash. SPI_POWER shall be used to power SPI BIOS flash on the carrier only.	+ 3.3VSB		
BIOS_DIS0#	A34	Selection strap to determine the BIOS boot device.	I 3.3VSB	PU 10k 3.3VSB	Carrier shall pull to GND or leave no-connect.
BIOS_DIS1#	B88	Selection strap to determine the BIOS boot device.	I 3.3VSB	PU 10k 3.3VSB	Carrier shall pull to GND or leave no-connect.

Table 28 Miscellaneous Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
I2C_CK	B33	General purpose I ² C port clock output/input	I/O 3.3V	PU 2k49 3.3VSB	
I2C_DAT	B34	General purpose I ² C port data I/O line	I/O 3.3V	PU 2k49 3.3VSB	
SPKR	B32	Output for audio enunciator, the "speaker" in PC-AT systems	O 3.3V		
WDT	B27	Output indicating that a watchdog time-out event has occurred.	O 3.3V		
FAN_PWMOUT	B101	Fan speed control. Uses the Pulse Width Modulation (PWM) technique to control the fan's RPM.	O OD 3.3V	PU10K	
FAN_TACHIN	B102	Fan tachometer input.	I OD	PU 51k 3.3V	Requires a fan with two pulse output.
TPM_PP	A96	Physical Presence pin of Trusted Platform Module (TPM). Active high. TPM chip has an internal pull-down. This signal is used to indicate Physical Presence to the TPM.	I 3.3V		Trusted Platform Module chip is optional.



Note

For the correct fan control implementation (FAN_PWMOUT, FAN_TACHIN), see the COM Express Design Guide.

Table 29 General Purpose I/O Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
GPO0	A93	General purpose output pins. Shared with SD_CLK. Output from COM Express, input to SD	O 3.3V		
GPO1	B54	General purpose output pins. Shared with SD_CMD. Output from COM Express, input to SD	O 3.3V		
GPO2	B57	General purpose output pins. Shared with SD_WP. Output from COM Express, input to SD	O 3.3V		
GPO3	B63	General purpose output pins. Shared with SD_CD. Output from COM Express, input to SD	O 3.3V		
GPI0	A54	General purpose input pins. Pulled high internally on the module. Shared with SD_DATA0. Bidirectional signal	I 3.3V	PU 10K 3.3V	Pull-up only active in GPIO mode
GPI1	A63	General purpose input pins. Pulled high internally on the module. Shared with SD_DATA1. Bidirectional signal	I 3.3V	PU 10K 3.3V	Pull-up only active in GPIO mode
GPI2	A67	General purpose input pins. Pulled high internally on the module. Shared with SD_DATA2. Bidirectional signal	I 3.3V	PU 10K 3.3V	Pull-up only active in GPIO mode
GPI3	A85	General purpose input pins. Pulled high internally on the module. Shared with SD_DATA3. Bidirectional signal.	I 3.3V	PU 10K 3.3V	Pull-up only active in GPIO mode

Table 30 Power and System Management Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
PWRBTN#	B12	Power button to bring system out of S5 (soft off), active on falling edge. Note: For proper detection, assert a pulse width of at least 16 ms.	I 3.3VSB	PU 10k 3.3VSB	
SYS_RESET#	B49	Reset button input. Active low input. Edge triggered. System will not be held in hardware reset while this input is kept low. Note: For proper detection, assert a pulse width of at least 16 ms.	I 3.3VSB	PU 20k 3.3VSB	
CB_RESET#	B50	Reset output from module to Carrier Board. Active low. Issued by module chipset and may result from a low SYS_RESET# input, a low PWR_OK input, a VCC_12V power input that falls below the minimum specification, a watchdog timeout, or may be initiated by the module software.	O 3.3V		
PWR_OK	B24	Power OK from main power supply. A high value indicates that the power is good.	I 3.3V		Set by resistor divider to accept 3.3V. Connected via series diode to onboard voltage monitor
SUS_STAT#	B18	Indicates imminent suspend operation; used to notify LPC devices.	O 3.3VSB		

Signal	Pin #	Description	I/O	PU/PD	Comment
SUS_S3#	A15	Indicates system is in Suspend to RAM state. Active-low output. An inverted copy of SUS_S3# on the carrier board (also known as "PS_ON#") may be used to enable the non-standby power on a typical ATX power supply.	O 3.3VSB		
SUS_S4#	A18	Indicates system is in Suspend to Disk state. Active low output.	O 3.3VSB		
SUS_S5#	A24	Indicates system is in Soft Off state.	O 3.3VSB		Not supported by chipset. Shorted with SUS_S4#.
WAKE0#	B66	PCI Express wake up signal.	I 3.3VSB	PU 10k 3.3VSB	
WAKE1#	B67	General purpose wake up signal. May be used to implement wake-up on PS/2 keyboard or mouse activity.	I 3.3VSB	PU 10k 3.3VSB	
BATLOW#	A27	Battery low input. This signal may be driven low by external circuitry to signal that the system battery is low, or may be used to signal some other external power-management event.	I 3.3VSB	PU 10k 3.3VSB	
THRM#	B35	Input from off-module temp sensor indicating an over-temp situation.	I 3.3V	PU 100k 3.3V	
THERMTRIP#	A35	Active low output indicating that the CPU has entered thermal shutdown.	O 3.3V		
SMB_CK	B13	System Management Bus bidirectional clock line.	I/O 3.3VSB	PU 10k 3.3VSB	10k if SMB is isolated. 2k0 if SMB is connected
SMB_DAT#	B14	System Management Bus bidirectional data line.	I/O OD 3.3VSB	PU.10k 3.3VSB	10k if SMB is isolated. 2k0 if SMB is connected
SMB_ALERT#	B15	System Management Bus Alert – active low input can be used to generate an SMI# (System Management Interrupt) or to wake the system.	I 3.3VSB	PU 10k 3.3VSB	10k if SMB is isolated. 2k0 if SMB is connected
LID#	A103	Lid button. Used by the ACPI operating system for a LID switch. Note: For proper detection, assert a pulse width of at least 16 ms.	I OD 3.3V	PU 15k 3.3VSB	
SLEEP#	B103	Sleep button. Used by the ACPI operating system to bring the system to sleep state or to wake it up again. Note: For proper detection, assert a pulse width of at least 16 ms.	I OD 3.3V	PU 15k 3.3VSB	

Table 31 General Purpose Serial Interface Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
SER0_TX	A98	General purpose serial port transmitter	O 3.3V		
SER1_TX	A101	General purpose serial port transmitter	O 3.3V		
SER0_RX	A99	General purpose serial port receiver	I 3.3V	51k 3.3V	
SER1_RX	A102	General purpose serial port receiver	I 3.3V	51k 3.3V	

Table 32 Module Type Definition Signal Description

Signal	Pin #	Description	I/O	Comment																												
TYPE0# TYPE1# TYPE2#	C54 C57 D57	<p>The TYPE pins indicate to the Carrier Board the Pin-out Type that is implemented on the module. The pins are tied on the module to either ground (GND) or are no-connects (NC). For Pinout Type 1, these pins are don't care (X).</p> <table border="1"> <thead> <tr> <th>TYPE2#</th> <th>TYPE1#</th> <th>TYPE0#</th> <th></th> </tr> </thead> <tbody> <tr> <td>X</td> <td>X</td> <td>X</td> <td>Pinout Type 1</td> </tr> <tr> <td>NC</td> <td>NC</td> <td>NC</td> <td>Pinout Type 2</td> </tr> <tr> <td>NC</td> <td>NC</td> <td>GND</td> <td>Pinout Type 3 (no IDE)</td> </tr> <tr> <td>NC</td> <td>GND</td> <td>NC</td> <td>Pinout Type 4 (no PCI)</td> </tr> <tr> <td>NC</td> <td>GND</td> <td>GND</td> <td>Pinout Type 5 (no IDE, no PCI)</td> </tr> <tr> <td>GND</td> <td>NC</td> <td>NC</td> <td>Pinout Type 6 (no IDE, no PCI)</td> </tr> </tbody> </table> <p>The Carrier Board should implement combinatorial logic that monitors the module TYPE pins and keeps power off (e.g deactivates the ATX_ON signal for an ATX power supply) if an incompatible module pin-out type is detected. The Carrier Board logic may also implement a fault indicator such as an LED.</p>	TYPE2#	TYPE1#	TYPE0#		X	X	X	Pinout Type 1	NC	NC	NC	Pinout Type 2	NC	NC	GND	Pinout Type 3 (no IDE)	NC	GND	NC	Pinout Type 4 (no PCI)	NC	GND	GND	Pinout Type 5 (no IDE, no PCI)	GND	NC	NC	Pinout Type 6 (no IDE, no PCI)	PDS	<p>TYPE[0:2]# signals are available on all modules following the Type 2-6 Pinout standard. The conga-TCA4 is based on the COM Express Type 6 pinout therefore the pins 0 and 1 are not connected and pin 2 is connected to GND.</p>
TYPE2#	TYPE1#	TYPE0#																														
X	X	X	Pinout Type 1																													
NC	NC	NC	Pinout Type 2																													
NC	NC	GND	Pinout Type 3 (no IDE)																													
NC	GND	NC	Pinout Type 4 (no PCI)																													
NC	GND	GND	Pinout Type 5 (no IDE, no PCI)																													
GND	NC	NC	Pinout Type 6 (no IDE, no PCI)																													
TYPE10#	A97	<p>Dual use pin. Indicates to the carrier board that a Type 10 module is installed. Indicates to the carrier that a Rev. 1.0/2.0 module is installed.</p> <table border="1"> <thead> <tr> <th>TYPE10#</th> <th></th> </tr> </thead> <tbody> <tr> <td>NC</td> <td>Pinout R2.0</td> </tr> <tr> <td>PD</td> <td>Pinout Type 10 pull down to ground with 4.7k resistor</td> </tr> <tr> <td>12V</td> <td>Pinout R1.0</td> </tr> </tbody> </table> <p>This pin is reclaimed from VCC_12V pool. In R1.0 modules this pin will connect to other VCC_12V pins. In R2.0 this pin is defined as a no-connect for Types 1-6. A carrier can detect a R1.0 module by the presence of 12 V on this pin. R2.0 module Types 1-6 will no-connect this pin. Type 10 modules shall pull this pin to ground through a 4.7k resistor.</p>	TYPE10#		NC	Pinout R2.0	PD	Pinout Type 10 pull down to ground with 4.7k resistor	12V	Pinout R1.0	PDS	Not connected to indicate "Pinout R2.0".																				
TYPE10#																																
NC	Pinout R2.0																															
PD	Pinout Type 10 pull down to ground with 4.7k resistor																															
12V	Pinout R1.0																															

Table 33 Power and GND Signal Descriptions

Signal	Pin #	Description	I/O	PU/PD	Comment
VCC_12V	A104-A109 B104-B109 C104-C109 D104-D109	Primary power input: +12 V nominal. All available VCC_12V pins on the connector(s) shall be used.	P		
VCC_5V_SBY	B84-B87	Standby power input: +5.0 V nominal. If VCC5_SBY is used, all available VCC_5V_SBY pins on the connector(s) shall be used. Only used for standby and suspend functions. May be left unconnected if these functions are not used in the system design.	P		
VCC_RTC	A47	Real-time clock circuit-power input. Nominally +3.0 V.	P		
GND	A1, A11, A21, A31, A41, A51, A57, A60, A66, A70, A80, A90, A100, A110, B1, B11, B21, B31, B41, B51, B60, B70, B80, B90, B100, B110 C1, C2, C5, C8, C11, C14, C21, C31, C41, C51, C60, C70,C73, C76, C80, C84, C87, C90, C93, C96, C100, C103, C110, D1, D2, D5, D8, D11, D14, D21, D31, D41, D51, D60, D67, D70, D73, D76, D80, D84, D87, D90, D93, D96, D100, D103, D110	Ground - DC power and signal and AC signal return path. All available GND connector pins shall be used and tied to Carrier Board GND plane.	P		

9 System Resources

9.1 I/O Address Assignment

The I/O address assignment of the conga-TCA4 module is functionally identical with a standard PC/AT. The BIOS assigns PCI and PCI Express I/O resources from FFF0h downwards. Non PnP/PCI/PCI Express compliant devices must not consume I/O resources in that area.

9.1.1 LPC Bus

On the conga-TCA4, the Platform Controller Hub (PCH) acts as the subtractive decoding agent. All I/O cycles that are not positively decoded are forwarded to the PCH and the LPC Bus. Some fixed I/O space ranges seen by the processor are:

Table 34 IO Space Ranges

Device	IO Address
8259 Master	20h-21h, 24h-25h, 28h-29h, 2Ch-2Dh, 30h-31h, 34h-35h, 38h-39h, 3Ch-3Dh
8254s	40h-43h, 50h-53h
Ps2 Control	60h, 64h
NMI Controller	61h, 63h, 65h, 67h
RTC	70h-77h
Port 80h	80h-83h
Init Register	92h
8259 Master	A0h- A1h, A4h-A5h, A8h-A9h, Ach-ADh, B0h-B1h, B4h-B5h, B8h-B9h, Bch-BDh, 4D0h-4D1h
PCU UART	3F8h-3FFh
Reset Control	CF9h
Active Power Management	B2h-B3h



- Note**
1. Some of these ranges are used by a Super I/O if implemented on the carrier board or are occupied by the COM Express on-module UARTs if these are enabled in the setup.
 2. If you require additional LPC Bus resources other than those mentioned above, or want more information about this subject, contact congatec technical support for assistance.

9.2 PCI Configuration Space Map

Table 35 PCI Configuration Space Map

Bus Number (hex)	Device Number (hex)	Function Number (hex)	Description
00h	00h	00h	SoC Transaction Router
00h	02h	00h	Graphics and Display
00h	12h	00h	SD Port
00h	13h	00h	SATA
00h	14h	00h	XHCI USB
00h	17h	01h	eMMC 4.5 Port
00h	1Ah	00h	Trusted Execution Engine
00h	1Bh	00h	HD Audio
00h	1Ch	00h	PCI Express Root Port 0
00h	1Ch	01h	PCI Express Root Port 1
00h	1Ch	02h	PCI Express Root Port 2
00h	1Ch	03h	PCI Express Root Port 3
00h	1Dh	00h	EHCI USB
00h	1Fh	00h	LPC: Bridge to Intel Legacy Port
00h	1Fh	03h	SMBus Port
03h	00h	00h	PLX PE8605 PCI Express Bridge
04h	01h	00h	PLX PCI Express Port 0
04h	02h	00h	PLX PCI Express Port 1
04h	03h	00h	PLX PCI Express Port 2
08h	00h	00h	Intel I210 Ethernet Network

Note

1. The PCI Express Ports are visible only if they are set to "Enabled" in the BIOS setup program and a device attached to the corresponding PCI Express port on the carrier board.
2. The above table represents a case when a single function PCI Express device is connected to all possible slots on the carrier board. The given bus numbers will change based on the actual configuration of the hardware.

9.3 PCI Interrupt Routing Map

Table 36 PCI Interrupt Routing Map

PIRQ	PCI BUS INT Line ¹	APIC Mode IRQ	Graphic	SD Card	SATA	XHCI	eMMC 4.5 Port	TXE	HD Audio	PCI-EX Root Port 0	PCI-EX Root Port 1	PCI-EX Root Port 2	PCI-EX Root Port 3	EHCI USB	SMBus Port	I210 Ethernet Network
A	INTA	16	x	x	x	x	x	x	x	x				x		x ³
B	INTB	17									x				x	x ⁴
C	INTC	18										x				x ⁵
D	INTD	19											x			x ²
E		20														
F		21														
G		22														
H		23														



Note

- ¹ These interrupt lines are virtual (message based).
- ² Interrupt used by single function PCI Express devices (INTA).
- ³ Interrupt used by multifunction PCI Express devices (INTB).
- ⁴ Interrupt used by multifunction PCI Express devices (INTC).
- ⁵ Interrupt used by multifunction PCI Express devices (INTD).

9.4 I²C Bus

There are no onboard resources connected to the I²C bus. Address 16h is reserved for congatec Battery Management solutions.

9.5 SMBus

System Management (SM) bus signals are connected to the Intel® Baytrail SoC and the SMBus is not intended to be used by off-board non-system management devices. For more information about this subject contact congatec technical support.

10 BIOS Setup Description

The following section describes the BIOS setup program. The BIOS setup program can be used to view and change the BIOS settings for the module. Only experienced users should change the default BIOS settings.

10.1 Entering the BIOS Setup Program.

The BIOS setup program can be accessed by pressing the or <ESC> key during POST.

10.1.1 Boot Selection Popup

Press the <F11> key during POST to access the Boot Selection Popup menu. A selection menu displays immediately after POST, allowing the operator to select either the boot device that should be used or an option to enter the BIOS setup program.

10.2 Setup Menu and Navigation

The congatec BIOS setup screen is composed of the menu bar, left frame and right frame. The menu bar is shown below:

Main	Advanced	Chipset	Boot	Security	Save & Exit
------	----------	---------	------	----------	-------------

The left frame displays all the options that can be configured in the selected menu. Grayed-out options cannot be configured. Only the blue options can be configured. When an option is selected, it is highlighted in white.

The right frame displays the key legend. Above the key legend is an area reserved for text messages. These text messages explain the options and the possible impacts when changing the selected option in the left frame.



Entries in the option column that are displayed in bold indicate BIOS default values.

The setup program uses a key-based navigation system. Most of the keys can be used at any time while in setup. The table below explains the supported keys:

Key	Description
← → Left/Right	Select a setup menu (e.g. Main, Boot, Exit).
↑ ↓ Up/Down	Select a setup item or sub menu.
+ - Plus/Minus	Change the field value of a particular setup item.
Tab	Select setup fields (e.g. in date and time).
F1	Display General Help screen.
F2	Load previous settings.
F9	Load optimal default settings.
F10	Save changes and exit setup.
ESC	Discard changes and exit setup.
ENTER	Display options of a particular setup item or enter submenu.

10.3 Main Setup Screen

When you first enter the BIOS setup, you will see the main setup screen. The main setup screen reports BIOS, processor, memory and board information and is for configuring the system date and time. You can always return to the main setup screen by selecting the 'Main' tab.

Feature	Options	Description
Main BIOS Version	No option	Displays the main BIOS version.
OEM BIOS Version	No option	Displays the additional OEM BIOS version.
Build Date	No option	Displays the date the BIOS was built.
Product Revision	No option	Displays the hardware revision of the board.
Serial Number	No option	Displays the serial number of the board.
BC Firmware Revision	No option	Displays the firmware revision of the congatec board controller.
MAC Address	No option	Displays the MAC address of the onboard Ethernet controller.
Boot Counter	No option	Displays the number of boot ups. Note: The value is limited to 16777215.
Running Time	No option	Displays the board-runtime in hours. Note: The value is limited to 65535.
Access Level	No option	Displays the user's privilege level.
Microcode Patch	No option	Displays the processor's microcode revision.
Total Memory	No option	Displays total amount of low voltage DDR3 on the system.

Feature	Options	Description
Intel® GOP Driver	No option	Displays the GOP Driver version.
Sec RC Version	No option	Displays the SEC revision.
TXE FW Version	No option	Displays the Trusted Execution Environment (TXE) firmware revision.
System Language	English	Displays the default system language.
System Date	Day of week, month/day/year	Specifies the current system date Note: The date is in month/day/year format.
System Time	Hour:Minute:Second	Specifies the current system time. Note: The time is in 24 hour format.

10.4 Advanced Setup

Select the advanced tab from the setup menu to enter the advanced BIOS setup screen. The menu is used for setting advanced features and only features described within this user's guide are listed.

Main	Advanced	Chipset	Boot	Security	Save & Exit
	Watchdog				
	Hardware Health Monitoring				
	Graphics				
	Intel® I211 Gigabit Network				
	Driver Health				
	Trusted Computing				
	RTC Wake				
	Module Serial Ports				
	Reserve Legacy Interrupt				
	ACPI				
	Super IO				
	Serial Port Console Redirection				
	CPU				
	PPM Configuration				
	Thermal Configuration				
	SATA				
	LPSS & SCC Configuration				
	PCI & PCI Express				
	UEFI Network Stack				

Main	Advanced	Chipset	Boot	Security	Save & Exit
	CSM & Option ROM Control				
	NVMe Configuration				
	USB				
	Platform Trust Technology				
	Security Configuration				
	IntelMRT Configuration				
	PC Speaker				

10.4.1 Watchdog Submenu

Feature	Options	Description
POST Watchdog	Disabled 30sec, 1min, 2min, 5min, 10min, 30min	Select the timeout value for the POST watchdog. The watchdog is only active during the POST of the system and provides a facility to prevent errors during boot up by performing a reset.
Stop Watchdog for User Interaction	No Yes	Select whether the POST watchdog should be stopped during the popup of the boot selection menu or while waiting for the setup password.
Runtime Watchdog	Disabled One-time Trigger Single Event Repeated Event	Select the operating mode of the runtime watchdog: 'One-time Trigger' - Disables watchdog after first trigger. 'Single Event' - Executes every stage only once before the watchdog is disabled. 'Repeated Event' - Executes last stage repeatedly until reset. Note: This watchdog will be initialized just before the operating system starts booting.
Delay	Disabled 10sec, 30sec, 1min, 2min, 5min, 10min, 30min	The runtime watchdog is delayed for the selected time. Note: Use this feature to ensure that the operating system has enough time to load.
Event 1	ACPI Event Reset Power Button	Select the type of event that will be generated when timeout 1 is reached.
Event 2	Disabled ACPI Event Reset Power Button	Select the type of event that will be generated when timeout 2 is reached.
Event 3	Disabled ACPI Event Reset Power Button	Select the type of event that will be generated when timeout 3 is reached.
Timeout 1	1sec, 2sec, 5sec, 10sec, 30sec , 1min, 2min, 5min, 10min, 30min	Select the timeout value for the first stage watchdog event.

Feature	Options	Description
Timeout 2	Same as 'Timeout 1'	Same as 'Timeout 1'.
Timeout 3	Same as 'Timeout 1'	Same as 'Timeout 1'.
Watchdog ACPI Event	Shutdown Restart	Select the operating system event that is initiated by the watchdog ACPI event. This feature performs a critical but orderly operating system shutdown or restart.



1. In ACPI mode, the “Watchdog ACPI Event” handler can not directly restart or shutdown the OS. For this reason the congatec BIOS will do one of the following:

For Shutdown: An over temperature notification is executed. This causes the operating system to shut down in an orderly fashion.

For Restart: An ACPI fatal error is reported to the OS.

2. Additionally, the conga-TCA4 module does not support the watchdog NMI mode.

10.4.2 Hardware Health Monitoring Submenu

Feature	Options	Description
CPU Temperature	No option	Displays the CPU temperature in °C.
Board Temperature	No option	Displays the board temperature in °C
DC Input Voltage	No option	Displays the actual voltage of the 5V standard power supply.
5V Standby	No option	Displays the actual voltage of the 5V standby power supply.
Input Current (5V Standard)	No option	Displays the actual current of the 5V Standard power supply.
CPU Fan Speed	No option	Displays the CPU fan speed in RPM.
Fan PWM Frequency Mode	Low Frequency High Frequency	Select fan PWM base frequency mode. Low frequency: 35.3Hz High frequency: 22.5kHz
Fan PWM Frequency (kHz)	1-63	Select fan PWM base in kHz. Default: 31 Note: This feature is only visible in high frequency mode.
Fan PWM Speed Settings	0%, 10%, 25%, 40%, 50%, 60%, 75%, 90%, 100%	Set maximum fan speed during boot up in percentage of the actual maximum fan speed.

10.4.3 Graphics Submenu

Feature	Options	Description
Active LFP Configuration	No Local Flat Panel Integrated LVDS	Select the active local flat panel (LFP) configuration.
Always Try Auto Panel Detect	No Yes	If set to 'Yes', the BIOS will use the EDID™ data set in an external EEPROM to configure the LFP. In case it cannot be found, the data set selected under 'Local Flat Panel Type' will be used.
Local Flat Panel Type	Auto VGA 640x480 1x18 (002h) VGA 640x480 1x18 (013h) WVGA 800x480 1x18 (01Fh) WVGA 800x480 1x24 (01Bh) SVGA 800x600 1x18 (01Ah) XGA 1024x768 1x18 (006h) XGA 1024x768 2x18 (007h) XGA 1024x768 1x24 (008h) XGA 1024x768 2x24 (012h) WXGA 1280x800 1x18 (01Eh) WXGA 1280x768 1x24 (01Ch) SXGA 1280x1024 2x24 (00Ah) SXGA 1280x1024 2x24 (018h) UXGA 1600x1200 2x24 (00Ch) HD 1920x1080 2x24 (01Dh) WUXGA 1920x1200 2x18 (015h) WUXGA 1920x1200 2x24 (00Dh) Customized EDID™ 1 Customized EDID™ 2 Customized EDID™ 3	Select a predefined LFP type or choose 'Auto' to let the BIOS automatically detect and configure the attached LVDS panel. Auto detection is performed by reading an EDID™ data set via the video I ² C bus. The number in brackets specifies the congatec internal number of the respective panel data set. Note: Customized EDID™ utilizes an OEM defined EDID™ data set stored in the BIOS flash device.
Backlight Inverter Type	None PWM I2C	Select the type of backlight inverter: 'PWM' - IGD PWM signal. 'I2C' - I2C backlight inverter device connected to the video I ² C bus.
PWM Inverter Polarity	Normal Inverted	Select PWM inverter polarity. Note: Only visible if 'Backlight Inverter Type' is set to 'PWM'.
PWM Inverter Frequency (Hz)	200 - 40000	Set the PWM inverter frequency in Hz. Note: Only visible if 'Backlight Inverter Type' is set to 'PWM'.
Backlight Setting	0%, 10%, 25%, 40%, 50%, 60%, 75%, 90%, 100%	Select backlight value in percentage of the maximum setting.
Inhibit Backlight	No Permanent Until End Of POST	Select whether the backlight-on signal should be activated when the panel is activated, remain inhibited until the end of BIOS POST, or remain inhibited permanently.
Force LVDS Backlight	No Yes	Force LVDS Enable and LVDS VDD signals unconditionally

Feature	Options	Description
LVDS SSC	Disabled 0.5%, 1.0%, 1.5%, 2.0%, 2.5%	Select LVDS spread-spectrum clock modulation depth. Performs center spreading and fixed modulation frequency of 32.9kHz.
Digital Display Interface 1	Auto Disabled DisplayPort HDMI/DVI	Select the output type of the DDI 1 .
Digital Display Interface 2	Auto Disabled DisplayPort HDMI/DVI	Select the output type of the DDI 2.

10.4.4 Intel® I211 Gigabit Network Connection Submenu

Feature	Options	Description
▶ NIC Configuration	Submenu	Configure Boot Protocol, Wake on LAN, Link Speed and VLAN.
Blink LEDs	0	Identify the physical network port by blinking the associated LED.
UEFI Driver	No option	Displays the UEFI Driver version.
Adapter PBA	No option	Displays the Adapter PBA.
Chip Type	No option	Displays the type of the Chip.
PCI Device ID	No option	Displays the PCI Device ID.
Bus:Device:Function	No option	
Link Status	Disconnected	Displays the Link Status.
MAC Address	No option	Displays the MAC Address.

10.4.4.1 NIC Configuration Submenu

Feature	Options	Description
Link Speed	Auto Negotiated 10 Mbps Half 10 Mbps Full 100 Mbps Half 100 Mbps Full	Specifies the port speed used for the selected boot protocol.
Wake on LAN	Enabled Disabled	Enable or disable the Wake on LAN (WOL) feature

10.4.5 Driver Health Submenu

Feature	Options	Description
► Intel® PRO/1000	Submenu	Displays health status for the drivers/controllers connected to the system.

10.4.5.1 Intel® PRO/1000 Submenu

Feature	Options	Description
Controller Information	No option	Provides health status for the drivers/controllers connected to the system.

10.4.6 Trusted Computing Submenu

Feature	Options	Description
Security Device Support	Disabled Enabled	Enable or disable TPM support. Note: Please restart your system for the change to take effect.

10.4.7 RTC Wake Submenu

Feature	Options	Description
Wake System At Fixed Time	Disabled Enabled	Enable this feature to wake the system from S5 using the RTC alarm.
Wake up hour	0 - 23	Specify the wake up hour. For example: Enter "3" for 3am and "15" for 3pm.
Wake up minute	0 - 59	Specify the wake up minute.
Wake up second	0 - 59	Specify the wake up second.

10.4.8 Module Serial Ports Submenu

Feature	Options	Description
Serial Port 0	Disabled Enabled	Enable or disable module's serial port 0.
Serial Port 1	Disabled Enabled	Enable or disable module's serial port 1.

10.4.9 Reserve Legacy Interrupt Submenu

Feature	Options	Description
Serial Port 0	Disabled Enabled	Enable or disable the module's serial port 0.
Reserve Legacy Interrupt 1,2,3	None IRQ3, IRQ4, IRQ5, IRQ6, IRQ10, IRQ11, IRQ14, IRQ15	Use this feature to reserve the interrupt for a legacy bus device. Note: The selected interrupt will not be assigned to a PCI/PCIe device.

10.4.10 ACPI Submenu

Feature	Options	Description
Enable ACPI Auto Configuration	Disabled Enabled	Enable or disable BIOS ACPI auto configuration
Hibernation Support	Disabled Enabled	Enable or disable the system's ability to hibernate (OS S4 sleep state). Note: If you want to use this feature, please ensure that the operating system supports it.
ACPI Sleep State	Suspend Disabled S3 (Suspend to RAM)	Select the state used for ACPI system sleep/suspend.
Lock Legacy Resources	Disabled Enabled	Enable this feature to lock legacy resources.
LID Support	Disabled Enabled	If this feature is enabled, COM Express LID# signal acts as ACPI lid.
Sleep Button Support	Disabled Enabled	If this feature is enabled, COM Express SLEEP# signal acts as ACPI sleep button.

10.4.11 Super IO Submenu

Feature	Options	Description
Super IO Chip	No option	Displays super IO chip.
SIO Clock	24 MHz , 48 MHz	Set super IO base clock.
▶ Serial Port 1 Configuration	Submenu	Serial port 1 submenu.
▶ Serial Port 2 Configuration	Submenu	Serial port 2 submenu.
▶ Parallel Port Configuration	Submenu	Parallel port submenu.

10.4.11.1 Serial Port 1 Configuration Submenu

Feature	Options	Description
Serial Port	Disabled Enabled	Enable or disable serial port (COM).
Device Settings	No option	Displays current device settings.
Change Settings	Auto IO=3F8h; IRQ=3,4,5,7,9,10,11, 12; IO=2F8h; IRQ=3,4,5,7,9,10,11, 12; IO=3E8h; IRQ=3,4,5,7,9,10,11, 12; IO=3E8h; IRQ=3,4,5,7,9,10,11, 12;	Select an optimal settings for super IO device.

10.4.11.2 Serial Port 2 Configuration Submenu

Feature	Options	Description
Serial Port	Enabled Disabled	Enable or disable serial port (COM).
Change Settings	Auto IO=3F8h; IRQ=3,4,5,7,9,10,11, 12; IO=2F8h; IRQ=3,4,5,7,9,10,11, 12; IO=3E8h; IRQ=3,4,5,7,9,10,11, 12; IO=3E8h; IRQ=3,4,5,7,9,10,11, 12;	Serial port 2 configuration options.
Device Mode	Standard Serial Port Mode IrDA Active pulse 1.6 uS IrDA Active pulse 3/16 bit time ASKIR Mode	Change the serial port mode.

10.4.11.3 Parallel Port Configuration Submenu

Feature	Options	Description
Parallel Port	Enabled Disabled	Enable or disable parallel port (LPT/LPTE).
Device Settings	No option	Displays current device settings.
Change Settings	Auto IO=378h; IRQ=5,7,9,10,11, 12 IO=278h; IRQ=5,7,9,10,11, 12 IO=3BCh; IRQ=5,7,9,10,11, 12	Select an optimal settings for super IO device.

Feature	Options	Description
Device Mode	STD Printer Mode SPP Mode EPP-1.9 and SPP Mode EPP-1.7 and SPP Mode ECP Mode ECP and EPP 1.9 Mode ECP and EPP 1.7 Mode	Change the parallel port mode.

10.4.12 Serial Port Console Redirection Submenu

Feature	Options	Description
COM0 Console Redirection	Disabled Enabled	Enable or disable serial port 0 console redirection.
▶ Console Redirection Settings	Submenu	Opens console redirection configuration submenu.
▶ Legacy Console Redirection Settings	Submenu	Opens Legacy console redirection settings submenu.
Serial Port for Out-of-Band Management / EMS Console Redirection	Disabled Enabled	Enable or disable 'Serial Port for Out-of-Band Management / Windows Emergency Management Services'.
▶ Console Redirection Settings	Submenu	Opens console redirection configuration sub menu.



Note
The Serial Port Console Redirection does not function on Windows OSes because Intel does not currently provide COM port driver for Windows OS.

10.4.12.1 Console Redirection Settings Submenu

Feature	Options	Description
Terminal Type	VT100 VT100+ VT-UTF8 ANSI	Set the terminal type.
Baudrate	9600, 19200, 38400, 57600, 115200	Set baud rate.
Data Bits	7, 8	Set number of data bits.

Feature	Options	Description
Parity	None Even Odd Mark Space	Set parity.
Stop Bits	1, 2	Set number of stop bits.
Flow Control	None Hardware RTS/CTS	Set flow control.
VT-UTF8 Combo Key Support	Disabled Enabled	Enable or disable the VT-UTF8 combination key support for ANSI/VT100 terminals.
Recorder Mode	Disabled Enabled	Enable this feature to only send text output over the terminal. Note: This feature is helpful to capture and record terminal data.
Resolution 100x31	Disabled Enabled	Enable or disable extended terminal resolution.
Legacy OS Redirection Resolution	80x24 80x25	Select the number of rows and columns for the legacy operating system redirection.
Putty KeyPad	VT100 LINUX XTERMR6 SCO ESCN VT400	Select the function key and keypad for Putty.
Redirection After BIOS POST	Disabled Enabled	If BootLoader is selected, Legacy console redirection is disabled before booting to Legacy OS. Default value is Always Enable which means Legacy console redirection is enabled for Legacy OS.

10.4.12.2 Legacy Console Redirection Settings Submenu

Empty.

10.4.12.3 Console Redirection Settings Out-of-Band Management Submenu

Feature	Options	Description
Terminal Type	VT100 VT100+ VT-UTF8 ANSI	Set the terminal type.
Baudrate	9600, 19200, 38400, 57600, 115200	Set the baud rate.

Feature	Options	Description
Flow Control	None Hardware RTS/CTS Software Xon/Xoff	
Data Bits	8	Set the number of data bits.
Parity	None	Set the parity.
Stop Bits	1	Set the number of stop bits.

10.4.13 CPU Submenu

Feature	Options	Description
► Socket 0 CPU Information	Submenu	Opens socket specific CPU information submenu.
CPU Speed	No option	Displays the CPU clock frequency
64-bit	No option	Displays whether 64-bit is supported.
Limit CUID Maximum	Disabled Enabled	If enabled, the processor limits the maximum CUID input value to 03h when queried, even if the processor supports a higher CUID input value. If disabled, the processor returns the actual maximum CUID input value of the processor when queried. Note: Limiting the CUID input value may be required for older operating systems that cannot handle the extra CUID information returned when using the full CUID input value.
Bi-directional PROCHOT	Disabled Enabled	If enabled, external agents can drive PROCHOT# to throttle the processor. If disabled, a processor thermal sensor trips (either core), the PROCHOT# will be driven.
Intel Virtualization Technology	Disabled Enabled	Enable or disable support for the Intel virtualization technology.
Power Technology	Disable Energy Efficient Custom	Select the power technology schema for the CPU.
EIST	Disabled Enabled	Enable or disable Enhanced Intel SpeedStep Technology (EIST).
Turbo Mode	Disabled Enabled	Enable or disable turbo mode.
P-State Coordination	HW_ALL SW_ALL SW_ANY	Select P-state coordination type.
Package C State Limit	C1, C3, C6, C7	Select the package C-state limit.

10.4.13.1 Socket 0 CPU Information Submenu

Feature	Options	Description
CPU Name	No option	Displays socket specific CPU name.
CPU Signature	No option	Displays CPU signature number.
Microcode Patch	No option	Displays the CPU microcode patch number.
Max CPU Speed	No option	Displays the maximal CPU clock frequency.
Min CPU Speed	No option	Displays the minimal CPU clock frequency.
Processor Cores	No option	Displays the number of CPU core on Socket CPU.
Intel HT Technology	No option	Displays the Intel HT Technology support information.
Intel VT-x Technology	No option	Displays the Intel VT-x Technology support information
L1 Data Cache	No option	Displays the Socket L1 data cache information.
L1 Code Cache	No option	Displays the Socket L1 code cache information.
L2 Cache	No option	Displays the Socket L2 cache information.
L3 Cache	No option	Displays the Socket L3 cache information.

10.4.14 PPM Configuration Submenu

Feature	Options	Description
EIST	Disabled Enabled	Enable or disable Enhanced Intel SpeedStep Technology (EIST).
CPU C state Report	Disabled Enabled	Enable or disable CPU state report to OS.
Max CPU C state	C7, C6, C1	Select maximum CPU C-state supported by the CPU.
SOix	Disabled Enabled	Enable or disable CPU SOix state support.

10.4.15 Thermal Configuration

Feature	Options	Description
DTS	Enabled Disabled	Enable or disable Digital Thermal Sensor (DTS).
Critical Trip Point	0 - 90	Set the temperature of the ACPI critical trip point at which the operating system will shut the system off.
OS Hibernate Temperature	0 - 110	Set the temperature that causes the operating system to trigger the system to hibernate. Default: 85
Passive Trip Point	0 - 90	Set the temperature of the ACPI passive trip point at which the operating system will begin throttling the processor. Default: 85

Feature	Options	Description
Full Speed Fan Trip Point	0 - 90	Set the temperature at which the fan is activated at full speed. Default: 80
Half Speed Fan Trip Point	0 - 90	Set the temperature at which the fan is activated at half speed. Default: 60
Fan Hysteresis	0 - 7	Set the number of degrees below the fan activation threshold that must be reached before turning off the fan.

10.4.16 SATA Submenu

Feature	Options	Description
SATA Controller	Enabled Disabled	Enable or disable SATA device
SATA Mode Selection	AHCI Mode	Determines how SATA controller operates.
SATA Interface Speed	Gen1, Gen2 , Gen3	Select SATA Interface Speed; CHV A1 always with Gen1 Speed.
Aggressive LPM Support	Enabled Disabled	Enable PCH to aggressively enter link power state.
► Software Feature Mask Configuration	Submenu	
SATA Port 0	Enabled Disabled	Enable or disable SATA Port.
Spin Up Device	Enabled Disabled	If enabled for any of ports, Staggered Spin Up will be performed and only the drives which have this option enabled will spin up at boot. Otherwise all drives spin up at boot.
Device Sleep Support	Enabled Disabled	Enable or disable Device Sleep Support on that port.
SATA Port 1	Enabled Disabled	Enable or disable SATA Port.
Spin Up Device	Enabled Disabled	If enabled for any of ports, Staggered Spin Up will be performed and only the drives which have this option enabled will spin up at boot. Otherwise all drives spin up at boot.
Device Sleep Support	Enabled Disabled	Enable or disable Device Sleep Support on that port.

10.4.16.1 Software Feature Mask Configuration Submenu

Feature	Options	Description
HDD Unlock	Enabled Disabled	If enabled, indicates that the HDD password unlock in the operating system is enabled.
LED Locate	Enabled Disabled	If enabled, indicates that the LED/SGPIO hardware is attached and ping to locate feature is enabled on the OS.

10.4.17 LPSS & SCC Configuration Submenu

Feature	Options	Description
SCC eMMC Support	ACPI Mode PCI Mode Disabled	Enable or disable SCC eMMC support.
eMMC Secure Erase	Enabled Disabled	Enable or disable eMMC secure erase support.
SCC SDIO Support (D17:F0)	ACPI Mode PCI Mode Disabled	Enable or disable SCC SDIO support
SCC SD Card Support (D18:F0)	ACPI Mode PCI Mode Disabled	Enable or disable SCC SD Card support.
SD Card 1.8v Switching Delay	0 - 999ms	Set SD card 1.8v switching delay.
SD Card 3.3v Discharge Delay	0 - 999ms	Set SD card 3.3v discharge delay. Default: 250
eMMC Driver Operating Mode	Auto Detect Basic Frequency Up to 26 MHz Up to 52 MHz	Select the operating frequency in eMMC driver.
eMMC RX DLL Tuning Support	Enabled Disabled	Enable or disable tuning support.
eMMC TX DLL Tuning Support	Enabled Disabled	Enable or disable tuning support.
LPSS with GPIO Devices Support	Disabled Enabled	Enable or disable GPIO ACPI devices support. 'Disable' - Disables all LPSS devices.
LPSS DMA #1	ACPI Mode PCI Mode Disabled	Enable or disable LPSS DMA #1 support.
LPSS DMA #2	ACPI Mode PCI Mode Disabled	Enable or disable LPSS DMA #2 support.
LPSS I2C #3	ACPI Mode PCI Mode Disabled	Enable or disable LPSS I2C #3 support.
Runtime D3 Support	Enabled Disabled	Enable or disable Runtime D3 support.
LPSS I2C #4	ACPI Mode PCI Mode Disabled	Enable or disable LPSS I2C #4 support.

Feature	Options	Description
LPSS HSUART #1	ACPI Mode PCI Mode Disabled	Enable or disable LPSS HSUART #1 support.
LPSS HSUART #2	ACPI Mode PCI Mode Disabled	Enable or disable LPSS HSUART #2 support.

10.4.18 PCI & PCI Express

Feature	Options	Description
PCI Bus Driver Version	No Option	Displays PCI bus driver version.
PCI Latency Timer	32 PCI Bus Clocks 64 PCI Bus Clocks 96 PCI Bus Clocks 128 PCI Bus Clocks 160 PCI Bus Clocks 192 PCI Bus Clocks 224 PCI Bus Clocks 248 PCI Bus Clocks	Select value to be programmed into PCI latency timer register.
PCI-X Latency Timer	32 PCI Bus Clocks 64 PCI Bus Clocks 96 PCI Bus Clocks 128 PCI Bus Clocks 160 PCI Bus Clocks 192 PCI Bus Clocks 224 PCI Bus Clocks 248 PCI Bus Clocks	Select value to be programmed into PCI latency timer register.
VGA Palette Snoop	Disabled Enabled	Enable or disable VGA palette registers snooping.
PERR# Generation	Disabled Enabled	Enable or disable PCI device to generate PERR#.
SERR# Generation	Disabled Enabled	Enable or disable PCI device to generate SERR#.
Above 4G Decoding	Disabled Enabled	Enable or disable 64-bit capable devices to be decoded in Above 4G address space. Note: The system must support 64-bit PCI decoding.
Don't Reset VC-TC Mapping	Disabled Enabled	If system has virtual channels, software can reset traffic class mapping through virtual channels, to its default state. Setting this option to enabled will not modify VC resources.

10.4.19 UEFI Network Stack

Feature	Options	Description
Network Stack	Enabled Disabled	Enable or disable the UEFI network stack.
IPv4 PXE Support	Enabled Disabled	If disabled, IPV4 PXE boot option will not be created.
IPv6 PXE Support	Enabled Disabled	If disabled, IPV6 PXE boot option will not be created.
PXE boot wait time	0 - 5	Set wait time to press ESC key to abort PXE Boot
Media detect count	1 - 50	Set the number of times the presence of media will be checked.

10.4.20 CSM & Option ROM Control Submenu

Feature	Options	Description
CSM Support	Enabled Disabled	Enable or disable the Compatibility Support Module (CSM).
CSM16 Module Version	No option	Displays the CSM module version number.
Gate A20 Active	Upon Request Always	Select legacy Gate A behavior.
Option ROM Messages	Force BIOS Keep Current	Enable or disable option ROM message.
INT19 Trap Response	Immediate Postponed	Select BIOS reaction on INT19 trapping by Option ROM: 'Immediate' - Executes the trap right away. 'Postpone' - Executes the trap during legacy boot.
Boot Option Filter	UEFI and Legacy Legacy Only UEFI Only	Select which devices / boot loaders the system should boot to.
Network	Do not launch UEFI only Legacy only	Select the execution of UEFI and legacy Network option ROMs.
Storage	Do not launch UEFI only Legacy only	Select the execution of UEFI and legacy Storage option ROMs.
Video	Do not launch UEFI only Legacy only	Select the execution of UEFI and legacy Video option ROMs
Other PCI Devices	UEFI only Legacy only	Select the execution of UEFI and legacy option ROMs for any PCI device other than network, video and storage.

10.4.21 Info Report Configuration

Feature	Options	Description
POST Report	Disabled Enabled	Enable or disable POST report support.
Delay Time	0 - 10 Until Press ESC	Set POST report time in seconds or select to wait till ESC key is pressed.
Error Message Report	Disabled Enabled	Enable or disable error message support.
Summary Screen	Disabled Enabled	Enable or disable summary screen.
Delay Time	0 - 10 Until Press ESC	Set summary screen from 0 to 10 seconds or select to wait till ESC key is pressed.

10.4.22 NVMe Submenu

Feature	Options	Description
NVMe controller and Drive Information	No option	

10.4.23 USB Submenu

Feature	Options	Description
USB Module Version	No option	Displays the version of the USB module.
USB Controllers	No option	Displays the available USB controllers.
USB Devices	No option	Displays the detected USB devices.
Legacy USB Support	Enabled Disabled Auto	Set legacy USB support: 'Enable' - Enables legacy USB support. 'Disable' - Keeps USB devices available only for EFI applications and BIOS setup. 'Auto' - Disables legacy support if no USB devices are connected.
xHCI Hand-off	Enabled Disabled	This is a workaround for OSes without xHCI hand-off support. The xHCI ownership change should be claimed by xHCI operating system driver.
USB Mass Storage Driver Support	Disabled Enabled	Enable or disable Mass Storage Driver support.
Port 60/64 Emulation	Disabled Enabled	Enable or disable I/O port 60h/64h emulation support. This should be enabled for the complete USB keyboard legacy support for non-USB aware OSes.

Feature	Options	Description
USB Transfer Timeout	1 sec 5 sec 10 sec 20 sec	Set the timeout value for control, bulk, and interrupt transfers.
Device Reset Timeout	10 sec 20 sec 30 sec 40 sec	Set USB legacy mass storage device start unit command timeout.
Device Power -Up Delay Selection	Auto Manual	Select maximum time a USB device might need before it properly reports itself to the host controller. 'Auto' - Selects a default value which is 100ms for a root port or derived from the hub descriptor for a hub port.
Device Power -Up Delay Value	0-40	Set power-up delay value in seconds. Default: 5

10.4.24 Platform Trust Technology

Feature	Options	Description
fTPM	Disable Enable	Enable or disable Trusted Platform Module (TPM) support.

10.4.25 Security Configuration

Feature	Options	Description
TXE HMRFPO	Enable Disable	Enable or disable Host ME Region Flash Protection Overwrite (HMRFPO).
TXE Firmware Update	Enabled Disabled	Enable or disable firmware update.
TXE EOP Message	Enabled Disabled	Enable or disable TXE End of Post (EOP) Message.

10.4.26 Intel® RMT Configuration Submenu

Feature	Options	Description
Intel RMT Support	Disabled Enabled	If enabled, Intel Ready Mode Technology (RMT) SSDT table will be loaded.
HW Notification	Disabled Enabled	Enable or disable hardware notification status.

10.4.27 PC Speaker Submenu

Feature	Options	Description
Debug Beeps	Disabled Enabled	Enable or disable general debug/status beep generation.
Input Device Debug Beeps	Disabled Enabled	Enable or disable input device debug beep generation.
Output Device Debug Beeps	Disabled Enabled	Enable or disable output device debug beep generation.
USB Driver Beeps	Disabled Enabled	Enable or disable USB driver beeps.

10.5 Chipset Setup

Select the 'Chipset' tab from the setup menu to enter the chipset setup screen.

Main	Advanced	Chipset	Boot	Security	Save & Exit
		Processor (Integrated Components)			
		Platform Controller Hub (PCH)			

10.5.1 Processor (Integrated Components) Submenu

Feature	Options	Description
▶ Intel IGD Configuration	Submenu	
▶ Graphics Power Management Control	Submenu	
▶ Memory Configuration Options	Submenu	
Total Memory	No option	Displays total amount of memory detected by the system
Memory Slot 0	No option	Displays memory detected by the system on slot 0
Memory Slot 1	No option	Displays memory detected by the system on Slot 1
Max TOLUD	2 GB 3 GB	Select maximum value of TOLUD. Dynamic assignment will adjust TOLUD based on largest MMIO length of installed graphic controller.

10.5.1.1 Intel® IGD Configuration Submenu

Feature	Options	Description
Internal Graphics Device	Enabled Disabled	Enable or disable Internal Graphics Device (IGD).
IGD Turbo	Auto Enabled Disabled	Select the IGD turbo feature: 'Auto' - Enables IGD turbo only when SOC stepping is B0 or above.
GFX Boost	Enabled Disabled	Enable or disable GFX boost.
PAVC	Disabled Enabled	Enable or disable Protected Audio Video Control (PAVC).
PR3	Disabled Enabled	Enable or disable PR3. This is a feature for Win 10 only.
DVMT Pre-Allocated	32M , 64M, 96M, 128M, 160M, 192M, 224M, 256M, 288M, 320M, 352M, 384M, 416M, 448M, 480M, 512M	Select DVMT 5.0 pre-allocated (fixed) graphics memory size used by the IGD.
DVMT Total Gfx Mem	128MB 256MB Max	Select DVMT 5.0 total graphic memory size used by the IGD.
Aperture Size	128MB 256MB 512MB	Select the aperture size.
GTT Size	2MB 4MB 8MB	Select the GTT size.
IGD Thermal	Enabled Disabled	Enable or disable IGD thermal.
Spread Spectrum clock	Enabled Disabled	Enable or disable spread spectrum clock.
WOPCMSZ	1MB 2MB 4MB 8MB	Select the size for WOPCMSZ.
ISP Enable/Disable	Enabled Disabled	Enable or disable ISP PCI device selection.
ISP PCI Device Selection	ISP PCI Device as B0D2F0 ISP PCI Device as B0D3F0 ISP PCI Device as B0D3F0 with Virtual ISP B0D2F0	Default ISP for Windows boot is PCI B0D2F0. Default for Linux boot is B0D3F0.

Feature	Options	Description
PUNIT Power Configuration	Disabled Enabled	Enable or disable PUNIT power configuration.
Svid Configuration	Platform Defaults Svid Config 0 Svid Config 1 Svid Config 3 Svid Config 4 BSW I2C PMIC Config	Choose the right SVID config.

10.5.1.2 Graphics Power Management Control Submenu

Feature	Options	Description
RC6 (Render Standby)	Enabled Disabled	Enable or disable render standby support.
Power Meter Lock	Enabled Disabled	Enable or disable power meter lock.

10.5.1.3 Memory Configuration Options Submenu

Feature	Options	Description
Rank Margin Tool EV Mode	Disabled Enabled	Enable or disable rank margin tool print out message support.
DDR DVFS	Disabled Enabled	Enable or disable DDR dynamic voltage and frequency scaling in MRC.
Memory Frequency Override	Disabled Enabled	Enable to allow override of memory frequency parameters that are automatically obtained from DDR3 DIMM SPD. Note: May cause memory instability if the selected frequency is not supported by the memory device. This option has no effect on systems configured without 'UseDimmSpd' option.
Frequency A selection	Auto 800 1067 1600 800(SKU333) 1000(SKU333) 1333(SKU333) 900(SKU360) 1800(SKU360) 933(SKU373) 1866(SKU373)	Select frequency A selection.

Feature	Options	Description
Frequency B selection	Auto 1067 800(SKU333) 1000(SKU333) 900(SKU360) 933(SKU373)	Select frequency B selection (Minimum DDR DVFS Frequency).
Auto Detect LPDDR3 DRAM	Disabled Enabled	Enable or disable automatic detection of LPDDR3 DRAM parameters.
LPDDR3 Chip Select	1 Rank 2 Ranks	Select LPDDR3 chip rank Note: 'Auto Detect' must be disabled to use this option.
Channel selection	Auto Single Dual	Select number of channels.
Channel Selection Bit 3:0	0, 1, 2 , 3, 4, 5, 6, 7, 8, 9, A, B, C, D, E, F	Set channel selection bit 3:0.
Channel Selection 4	0, 1 , 2, 3, 4, 5, 6, 7, 8, 9, A, B, C, D, E, F	BMISC Channel select 4 for channel hashing.
Bank Address Hashing	Disabled Enabled	Enable or disable bank address hashing.
Rank Select Interleaving	Disabled Enabled	Enable or disable rank select interleaving.
Dynamic Self Refresh	Disabled Enabled	Enable or disable PUNIT driven DUNIT DDR dynamic self refresh.
DRAM PM5	Disabled Enabled	Enable or disable DRAM PM5 PUNIT configuration.
DDR3 2N Mode	Disabled Enabled	Enable to set the DDR3 mode to 2N. 1N mode is used by default.
RX Power Training	Enabled Disabled	Enable or disable RX Power Training.
TX Power Training	Enabled Disabled	Enable or disable TX Power Training.
MRC Fast Boot	Enabled Disabled	Enable or disable MRC fast boot. If disabled, forces MRC training.
Scrambler	Enabled Disabled	Enable or disable scrambler.
DRP Lock	Disabled Enabled	Enable or disable DRP lock.
REUT Lock	Disabled Enabled	Enable or disable REUT lock.

Feature	Options	Description
RH Prevention	Disabled Enabled	Enable to prevent row hammer attacks. This function increases the average time between sending REF commands to DRAM.

10.5.2 Platform Controller Hub (PCH) Submenu

Feature	Options	Description
▶ Security Configuration	Submenu	Security Configuration Submenu.
▶ Azalia Configuration	Submenu	Azalia HD Audio Submenu.
▶ USB Configuration	Submenu	USB Submenu.
▶ PCI Express Configuration	Submenu	PCI Express Configuration Submenu.
Serial IRQ Mode	Quiet Continuous	Select IRQ Serial Mode
CLKRUN# Logic	Enable Disable	Enable the CLKRUN# logic to stop the LPC clocks when possible. Requires Serial IRQ Mode to be set to Quiet as well.
Isolate SMBus Segments	Never During POST Always	Isolate the off-module/external SMBus segment from the on-module SMBus segment. This can be a workaround for non spec conform external SMBus devices.

10.5.2.1 Security Configuration Submenu

Feature	Options	Description
RTC Lock	Disabled Enabled	Enable or disable bytes 38h-3Fh in the upper and lower 128-byte bank of RTC RAM lockdown.
BIOS Lock	Enabled Disabled	Enable or disable BIOS lock.
Global SMI Lock	Enabled Disabled	Enable or disable global SMI lock.

10.5.2.2 Azalia Configuration Submenu

Feature	Options	Description
LPE Audio Support	Disabled PCI Mode ACPI Mode	Select LPE audio support.

Feature	Options	Description
Audio Controller	Enabled Disabled	Enable or disable audio controller.
Azalia Vci Enable	Enabled Disabled	Enable or disable Azalia Vci.
Azalia Docking Support Enable	Enabled Disabled	Enable or disable Azalia Docking support.
Azalia PME Enable	Enabled Disabled	Enable or disable Azalia PME support.
Azalia HDMI Codec	Enabled Disabled	Enable or disable Azalia HDMI codec.
HDMI Port B	Enabled Disabled	Enable or disable HDMI port B audio.
HDMI Port C	Enabled Disabled	Enable or disable HDMI port C audio.
HDMI Port D	Enabled Disabled	Enable or disable HDMI port D audio.

10.5.2.3 USB Configuration Submenu

Feature	Options	Description
XHCI Mode	Enabled Disabled	Mode of operation of xHCI controller
SSIC Support Enable	Disabled Enabled	Enable or disable SSIC support.
SSIC Init Sequence	SSIC Initialization Sequence 1 SSIC Initialization Sequence 2	Select sequence 1 for Windows. Select sequence 2 for Android.
SSIC Port 1	Enabled Disabled	Enable or disable SSIC port 1.
SSIC Port 2	Enabled Disabled	Enable or disable SSIC port 2.
HSIC Port 1	Enabled Disabled	Enable or disable HSIC port 1.
HSIC Port 2	Enabled Disabled	Enable or disable HSIC port 2.
USB2 PHY Power Gating	Auto Disabled Enabled	Select USB2 PHY power gating.

Feature	Options	Description
USB3 PHY Power Gating	Auto Disabled Enabled	Select USB3 PHY power gating.

10.5.2.4 PCI Express Configuration Submenu

Feature	Options	Description
▶ PCIE Express Root Port 1	Submenu	
▶ PCIE Express Root Port 2	Submenu	
▶ PCIE Express Root Port 3	Submenu	
▶ PCIE Express Root Port 4	Submenu	
▶ PCIE Express S0ix Settings	Submenu	
Native PCI Express Support	Disabled Enabled	Enable or disable native operating system PCIe support

10.5.2.5 PCIE Express Root Port 1,2,3 & 4

Feature	Options	Description
PCI Express Root Port 1	Enabled Disabled	Enable or disable the PCIe root port.
ASPM	Auto Disabled L0s L1s L0sL1	Select PCIe Active State Power Management (ASPM) setting.
URR	Disabled Enabled	Enable or disable PCIe Unsupported Request Reporting (URR).
FER	Disabled Enabled	Enable or disable PCIe device Fatal Error Reporting (FER).
NFER	Disabled Enabled	Enable or disable PCIe device Non-Fatal Error Reporting (NFER).
CER	Disabled Enabled	Enable or disable PCIe device Correctable Error Reporting (CER).
SEFE	Disabled Enabled	Enable or disable root PCIe System Error on Fatal Error (SEFE).

Feature	Options	Description
SENF	Disabled Enabled	Enable or disable root PCIe System Error on Non-Fatal Error (SENF).
SECE	Disabled Enabled	Enable or disable root PCIe System Error on Correctable Error (SECE).
PME SCI	Disabled Enabled	Enable or disable PCIe Power Management Event (PME) SCI.
Ext Sync	Disabled Enabled	Enable or disable express ext sync.
PCIe Speed	Auto Gen2 Gen1	Select PCIe speed. Note: CHV A1 always with Gen 1 Speed.
Detect Non-compliant Device	Disabled Enabled	Enable to detect non-compliant PCIe devices on the PEG port. Note: Does not detect all devices.
L1 Substates	Disabled L1.1 L1.2 L1.1 & L1.2	Select PCIe L1 substates setting.
Non-Common Clock With SSC Enabled Mode	Enabled Disabled	If enabled, assumes the root port is operating at non-common clock.
Transmitter Half Swing	Enabled Disabled	Enable or disable transmitter half swing.
Tx Eq Deemphasis Selection	3.5dB 6dB	Select the level of de-emphasis for an upstream component.

10.5.2.6 PCIE Express S0ix Settings Submenu

Feature	Options	Description
D0 S0ix Policy	PCIe RC shall be in D3 S0i1 is the deepest S0ix state PCIe RC in in D0 when entering S0ix Reserved	Select PCIe D0 S0ix policy.
Evaluate CLKREQ State	Enabled Disabled	Enable or disable evaluation of CLKREQ state.
CLKREQ# Enable	CLKREQ# [0] CLKREQ# [1] CLKREQ# [2] CLKREQ# [3]	Evaluate CLKREQ# [x] during PCIe in D0 S0ix entry and exit criteria checking.

Feature	Options	Description
S0ix LTR Threshold (Latency Scale)	1ns 32ns 1024ns 32,768ns 1,048,576ns 33,554,321ns	Select PCIe S0ix LTR threshold for latency scale..
PCIe LTR Threshold (Latency Value)	150	Set the PCIe S0ix LTR threshold latency value. This value is multiplied by the latency scale.

10.6 Security Setup

Select the Security tab from the setup menu to enter the Security setup screen.

10.6.1 Security Settings

Feature	Options	Description
BIOS Password	No options	Set BIOS password.
BIOS Lock	Enabled Disabled	Enable or disable the BIOS lock feature
BIOS Update and Write Protection	Disabled Enabled	Enable or disable BIOS update
► Secure Boot Menu	Submenu	Customizable secure boot settings.

10.6.2 Secure Boot Menu

Feature	Options	Description
System Mode	No options	Shows system mode.
Secure Boot	No options	Shows secure boot status.
Vendor Keys	No options	Shows vendor keys status.
Secure Boot	Disabled Enabled	Secure boot can be enabled if the system is running in user mode with enrolled Platform Key (PK) and when CSM function is disabled.
Secure Boot Mode	Standard Custom	Select secure boot mode.
► Key Management	Submenu	

10.6.2.1 Key Management Submenu

Feature	Options	Description
Provision Factory Default Keys	Disabled Enabled	Install factory default secure boot keys when system is in setup mode.
▶ Enroll all Factory Default Keys		Force system to user mode and install all factory default keys.
▶ Platform Key(PK)		
▶ Key Exchange Keys		
▶ Authorized Signatures		
▶ Forbidden Signatures		
▶ Authorized TimeStamps		

10.7 Boot Setup

Select the Boot tab from the setup menu to enter the Boot setup screen.

10.7.1 Boot Settings Configuration

Feature	Options	Description
Setup Prompt Timeout	0 - 65535	Set number of seconds to wait for setup activation key. Default: 1 '65535' - Waits indefinitely (0xFFFF). '0' - Does not wait (not recommended).
Bootup NumLock State	On Off	Set the keyboard numlock state.
Quiet Boot	Disabled Enabled	'Disabled' - Displays normal POST diagnostic messages. 'Enabled' - Displays OEM logo instead of POST messages. Note: The default OEM logo is a dark screen.
Enter Setup If No Boot Device	No Yes	Select whether the setup menu should be started if no boot device is connected.
Enable Popup Boot Menu	No Yes	Select whether the popup boot menu can be started.
Boot Priority Selection	Device Based Type Based	Set boot priority: 'Device Based' - Select boot priority from a list of currently detected devices. 'Type Based' - Select boot priority from a list of device types even if they are not connected yet.
Boot Option Sorting Method	Legacy First UEFI First	Set boot option sorting method: 'Legacy First' - Tries all legacy boot option first before first UEFI boot option. 'UEFI First' - Tries all UEFI boot options before first legacy boot option.

Feature	Options	Description
Power Loss Control	Remain Off Turn On Last State	Select the mode of operation if an AC power loss occurs: 'Remain Off' - Keeps the power off until the power button is pressed. 'Turn On' - Restores power to the computer. 'Last State' - Restores the previous power state before power loss occurred. Note: Only works with an ATX type power supply.
AT Shutdown Mode	System Reboot Hot S5	Determines the behavior of an AT-powered system after a shutdown.
System Off Mode	G3/Mech Off S5/Soft Off	Define system state after shutdown when a battery system is present.
Fast Boot	Disabled Enabled	Enable or disable boot with initialization of a minimal set of devices required to launch active boot option. Has no effect for BBS / legacy boot options.
1st Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	
2nd Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	
3rd Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	

Feature	Options	Description
4th Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	
5th Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	
6th Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	
7th Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	

Feature	Options	Description
8th Boot Device	Disabled SATA 0 Drive SATA 1 Drive USB Harddisk USB CDROM Other USB Device Onboard LAN External LAN Firmware-based Bootloader Other Device	
Battery Support	Auto (Battery Manager) Battery-Only On I2C Bus Battery-Only On SMBus	Select Battery system support.
UEFI Fast Boot	Disabled Enabled	If enabled, initializes a minimum set of devices required to launch active boot option. No effect for BBS / legacy boot options.
New Boot Option Policy	Disabled Enabled	Enable or disable the placement of newly detected UEFI boot options.

Note

1. The term 'AC power loss' stands for the state when the module loses the standby voltage on the 5V_SB pins. On congatec modules, the standby voltage is continuously monitored after the system is turned off. If within 30 seconds the standby voltage is no longer detected, then this is considered an AC power loss condition. If the standby voltage remains stable for 30 seconds, then it is assumed that the system was switched off properly.
2. Inexpensive ATX power supplies often have problems with short AC power sags. When using these ATX power supplies it is possible that the system turns off but does not switch back on, even when the PS_ON# signal is asserted correctly by the module. In this case, the internal circuitry of the ATX power supply has become confused. Usually another AC power off/on cycle is necessary to recover from this situation.

10.8 Save & Exit Menu

Select the Save & Exit tab from the setup menu to enter the Save & Exit setup screen. You can display a Save & Exit screen option by highlighting it using the <Arrow> keys.

Feature	Description
Save Changes and Exit	Exit setup menu after saving the changes. The system is only reset if settings have been changed.
Discard Changes and Exit	Exit setup menu without saving any changes.
Save Changes and Reset	Save changes and reset the system.
Discard Changes and Reset	Reset the system without saving any changes.
Save Options	
Save Changes	Save changes made so far to any of the setup options. Stay in setup menu.
Discard Changes	Discard changes made so far to any of the setup options. Stay in setup menu.
Restore Defaults	Restore default values for all the setup options.
Boot Override	
List of all boot devices currently detected	Select device to leave setup menu and boot from the selected device. Only visible and active if Boot Priority Selection setup node is set to "Device Based".

11 Additional BIOS Features

The BIOS setup description of the conga-TCA4 can be viewed without having access to the module. However, access to the restricted area of the congatec website is required in order to download the necessary tool (CgMlfViewer) and Menu Layout File (MLF).

The MLF contains the BIOS setup description of a particular BIOS revision. The MLF can be viewed with the CgMlfViewer tool. This tool offers a search function to quickly check for supported BIOS features. It also shows where each feature can be found in the BIOS setup menu.

For more information, read the application note “AN42 - BIOS Setup Description” available at www.congatec.com.



Note

If you do not have access to the restricted area of the congatec website, contact your local congatec sales representative.

11.1 BIOS Versions

The BIOS displays the BIOS project name and the revision code during POST, and on the main setup screen. The initial production BIOS for conga-TCA4 is identified as TA40R1xx, where:

- TA41 is the BIOS for modules with Braswell Single Channel Memory SoC
- TA42 is the BIOS for modules with Braswell Dual Channel Memory SoC
- R is the identifier for a BIOS ROM file, 1 is the feature number and xx is the major and minor revision number

The TA41 and TA42 BIOS binary size is 8 MB.

11.2 Updating the BIOS

BIOS updates are recommended to correct platform issues or enhance the feature set of the module. The conga-TCA4 features a congatec/AMI AptioEFI firmware on an onboard flash ROM chip. You can update the firmware with the congatec System Utility. The utility has five versions—UEFI shell, DOS based command line¹, Win32 command line, Win32 GUI, and Linux version.

For more information about “Updating the BIOS” refer to the user’s guide for the congatec System Utility “CGUTLm1x.pdf” on the congatec website at www.congatec.com.



Note

¹. *Deprecated*



Caution

The DOS command line tool is not officially supported by congatec and therefore not recommended for critical tasks such as firmware updates. We recommend to use only the UEFI shell for critical updates.

11.3 Recovering from External Flash

The following congatec documents describe how to recover a congatec module from external flash. You can find these documents on the congatec website:

- AN1_BIOS_Update.pdf
- AN5_BIOS_Update_And_Write_Protection.pdf
- AN7_External_BIOS_Update.pdf

11.4 Supported Flash Devices

The conga-TCA4 supports the following flash devices:

- Winbond W25Q64JVSSIQ (8MB)

The flash device listed above has been tested and can be used on the carrier board for external BIOS support. For more information about external BIOS support, refer to the Application Note AN7_External_BIOS_Update.pdf on the congatec website at <http://www.congatec.com>.